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(71) Applicant: ELISHA HOLDING LLC [US/US]; 2000 US
HWY 63 South, Moberly, MO 65270 (US).

(72) Inventors: HEIMANN, Robert, L.; #2 Sunrise Circle,
Centralia, MO 65240 (US). POPOV, Branko; 348 Con-
rad Circle, Columbia, SC 29212 (US). FLINT, Bruce;
1500 Affirmed, Columbia, MO 65202 (US). SLAVKOV,
Dragan; 1600 Park Circle, Apartment #15, Columbia, SC
29212 (US). BISHOP, Craig, V.; 1750 Overview Drive,
Rock Hill, SC 29730 (US).

(74) Agent: BOYER, Michael, K.; Chief Patent Counsel,
Orscheln Management Co, 2000 US HWY 63 South,
Moberly, MO 65270 (US).

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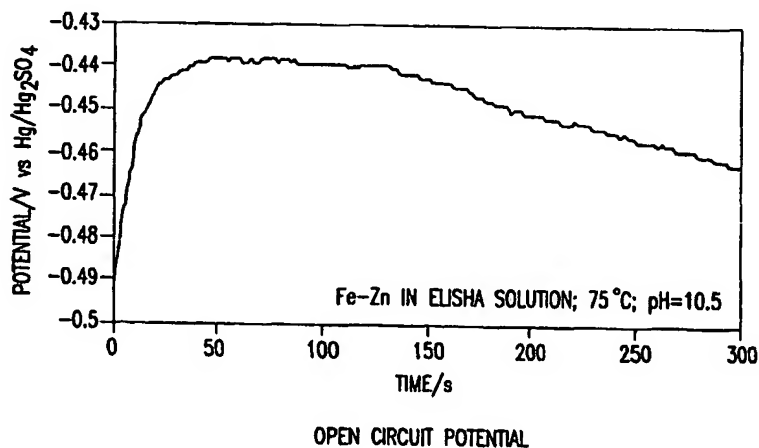
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(54) Title: AN ELECTROLESS PROCESS FOR TREATING METALLIC SURFACES AND PRODUCTS FORMED THEREBY



(57) Abstract: The disclosure relates to process for forming a deposit on the surface of a metallic or conductive surface. The process employs an electroless process to deposit a silicate containing coating or film upon a metallic or conductive surface.

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NON-PROVISIONAL PATENT APPLICATION

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AN ELECTROLESS PROCESS FOR TREATING METALLIC SURFACES AND
PRODUCTS FORMED THEREBY

The subject matter herein claims benefit of previously filed U.S. Patent Application Serial Numbers 60/381,024, filed on May 15, 2002 and 60/310,007, filed on August 03, 2002, both entitled "An Electroless Process For Treating Metallic Surfaces And Product Formed Thereby"; the disclosure of both is hereby incorporated by reference.

FIELD OF THE INVENTION

The instant invention relates to a process for forming a deposit on the surface of a metallic or conductive surface. The process employs a process to deposit, for example, a mineral containing coating or film upon a metallic, metal containing or an electrically conductive surface.

BACKGROUND OF THE INVENTION

Silicates have been used in electrocleaning operations to clean steel, tin, among other surfaces. Electrocleaning is typically employed as a cleaning step prior to an electroplating operation. Usage of silicates as cleaners is described in "Silicates As Cleaners In The Production of Tinplate" is described by L.J. Brown in February 1966 edition of Plating; European Patent No. 00536832/EP B1 (Metallgesellschaft AG); U.S. Patent Nos. 5,902,415, 5,352,296 and 4,492,616.

Processes for electrolytically forming a protective layer or film by using an anodic method are disclosed by U.S. Patent No. 3,658,662 (Casson, Jr. et al.), and United Kingdom Patent No. 498,485.

U.S. Patent No. 5,352,342 to Riffe, which issued on October 4, 1994 and is entitled "Method And Apparatus For Preventing Corrosion Of Metal Structures" that describes using electromotive forces upon a zinc solvent containing paint; hereby incorporated by reference. U.S. Patent Nos. 5,700,523, and 5,451,431; and German

5 Patent No. 93115628 describes a processes for using alkaline metasilicates to treat metallic surfaces.

The disclosure of the previously identified patents and publications is hereby incorporated by reference.

10

SUMMARY OF THE INVENTION

The instant invention solves problems associated with conventional practices by providing an electroless process for treating metallic surfaces. By "electroless" it is meant that no current is applied from an external source (a current may be generated in-situ due to an interaction between the metallic surface and the medium). The process
15 employs a silicate medium having a controlled and predetermined silicate concentration, temperature and pH. As a result, the silicate medium that interacts with the metallic surface to form surface having one or more improved properties. The inventive process controls the medium's characteristics and the surrounding environment in order to obtain a desired film or layer upon the metal surface, e.g., a film or layer having low surface
20 porosity or high density. The characteristics of the film or layer can be controlled or modified by varying the temperature, pH, lattice builders (i.e., medium dopants), rate of formation, heat, pressure, pre and post treatments and silicate concentration.

The inventive process can form a surface comprising a mineral layer comprising an amorphous matrix surrounding or incorporating metal silicate crystals upon the
25 substrate. The characteristics of the mineral layer are described in greater detail in the copending and commonly assigned patent applications listed below.

A metallic surface that is treated (e.g., forming the mineral layer) by the inventive process can possess improved corrosion resistance, increased electrical resistance, heat resistance, flexibility, resistance to stress crack corrosion, adhesion to topcoats, among
30 other properties. The improved heat resistance broadens the range of processes that can be performed subsequent to forming the inventive layer, e.g., heat cured topcoatings, stamping/shaping, riveting, among other processes. The treated surface also imparts greater corrosion resistance (e.g., ASTM B-117), among other beneficial properties, than conventional tri-valent or hexa-valent chromate systems. The inventive process can
35 provide a zinc-plate article having an ASTM B-117 resistance to white rust of at least

5 about 96 hours (and normally greater than about 150 hours), and resistance to red rust of at least about 250 (and normally greater than about 400 hours). The corrosion resistance can be improved by adding a dopant to the silicate medium, using a rinse and/or applying at least one sealer/topcoating.

10 The inventive process is a marked improvement over conventional methods by obviating the need for solvents or solvent containing systems to form a corrosion resistant layer, e.g., a mineral layer. In contrast, to conventional methods the inventive process can be substantially solvent free. By "substantially solvent free" it is meant that less than about 5 wt.%, and normally less than about 1 wt.% volatile organic compounds (V.O.C.s) are present in the electrolytic environment.

15 The inventive process is also a marked improvement over conventional methods by reducing, if not eliminating, chromate and/or phosphate containing compounds (and issues attendant with using these compounds such as waste disposal, worker exposure, among other undesirable environmental impacts). While the inventive process can be employed to enhance chromated or phosphated surfaces, the inventive process can
20 replace these surfaces with a more environmentally desirable surface. The inventive process, therefore, can be "substantially chromate free" and "substantially phosphate free" and in turn produce articles that are also substantially chromate (hexavalent and trivalent) free and substantially phosphate free. The inventive process can also be substantially free of heavy metals such as chromium, lead, cadmium, barium, among
25 others. By substantially chromate free, substantially phosphate free and substantially heavy metal free it is meant that less than 5 wt.% and normally about 0 wt.% chromates, phosphates and/or heavy metals are present in a process for producing an article or the resultant article.

30 CROSS REFERENCE TO RELATED PATENTS
AND PATENT APPLICATIONS

The subject matter of the instant invention is related to copending and commonly assigned WIPO Patent Application Publication No. WO 98/33960, Non-Provisional U.S.
35 Patent Application Serial Nos. 09/814,641; 08/850,323 (Now U.S. Patent No. 6,165,257);

5 08/850,586 (Now U.S. Patent No. 6,143,420); and 09/016,853 (now allowed), filed
respectively on May 2, 1997 and January 30, 1998, and 08/791,337 (now U.S. Patent No
5,938,976), filed on January 31, 1997, in the names of Robert L. Heimann et al., as a
continuation in part of Serial No. 08/634,215 (filed on April 18, 1996) in the names of
Robert L. Heimann et al., and entitled "Corrosion Resistant Buffer System for Metal
10 Products", which is a continuation in part of Non-Provisional U.S. Patent Application
Serial No. 08/476,271 (filed on June 7, 1995) in the names of Heimann et al., and
corresponding to WIPO Patent Application Publication No. WO 96/12770, which in turn
is a continuation in part of Non-Provisional U.S. Patent Application Serial No.
08/327,438 (filed on October 21, 1994), now U.S. Patent No. 5,714,093.

15 The subject matter of this invention is related to Non-Provisional Patent
Application Serial No. 09/016,849 (Attorney Docket No. EL004RH-1), filed on January
30, 1998 and entitled "Corrosion Protective Coatings". The subject matter of this
invention is also related to Non-Provisional Patent Application Serial No. 09/016,462
(Attorney Docket No. EL005NM-1), filed on January 30, 1998 and entitled "Aqueous
20 Gel Compositions and Use Thereof" (now U.S. Patent No. 6,033,495).

The subject matter of this invention is also related to Non-Provisional Patent
Application Serial No. 09/814,641 (Attorney Docket No. EL008RH-6), filed on March
22, 2001, and entitled "An Energy Enhanced Process For Treating A Conductive Surface
And Products Formed Thereby" (and corresponds to PCT Patent Application Serial No.
25 PCT/US01/09293), and Non-Provisional Patent Application Serial No. _____
(Attorney Docket No. EL023RH-1), filed on August 03, 2002 and entitled "An
Electrolytic And Electroless Process For Treating Metallic Surfaces And Products
Formed Thereby", and Serial No. _____ (Attorney Docket No. EL022RH-1), filed on
August 03, 2002 and entitled "Process For Treating A Conductive Surface And Products
30 Formed Thereby".

The disclosure of the previously identified patents, patent applications and
publications is hereby incorporated by reference.

5

BRIEF DESCRIPTION OF THE DRAWINGS

Fig.1 illustrates the open-circuit potential of galvanized steel panels immersed in the inventive medium having a pH 10.5.

Fig. 2 illustrates the open-circuit potential of galvanized steel panels immersed in the inventive medium having a pH 11.

Figure 3 illustrates the open-circuit potential of galvanized steel panels immersed in the inventive medium having a pH of 11.5.

Figure 4 illustrates the open-circuit potential of galvanized steel panels immersed in the inventive medium having a pH 12.

Fig. 5 illustrates the corrosion potentials of galvanized steel panels immersed in the inventive medium having a temperature of 75C and pHs of 10.5, 11, 11.5 and 12.

Fig. 6 illustrates the corrosion potentials of galvanized steel panels immersed in the inventive medium having a temperature of 80C and pHs of 10.5, 11, 11.5 and 12.

Figure 7 illustrates the open circuit potential for galvanized steel panels exposed to pHs of 10.5, 11 and 12.

Figure 8 illustrates a comparison of the SEM and EDAX analysis of samples exposed to the inventive medium and rinsed immediately and rinsed after 24 hours.

Figure 9 illustrates a comparison of increasing amounts of sodium borohydride addition to the inventive medium.

Figure 10 illustrates a comparison of corrosion resistance of samples treated with the inventive medium with sodium borohydride addition.

Figure 11 illustrates a comparison of corrosion resistance of samples treated with the inventive medium with sodium borohydride addition and a thermal post-treatment.

Figure 12 illustrates a voltagrams for samples treated in the inventive medium with sodium borohydride addition.

Figure 13 illustrates inhibiting efficiencies based upon the voltagrams of Figure 12.

Figure 14 illustrates a voltagrams for samples treated in the inventive medium with sodium borohydride addition and a thermal post-treatment.

Figure 15 illustrates inhibiting efficiencies based upon the voltagrams of Figure 14.

Figure 17 illustrates inhibiting efficiencies based upon the voltagrams of Figure 16.

Figure 19 illustrates the affect on inhibiting efficiencies on samples having a thermal post-treatment after immersion in water for one week.

Figure 21 illustrates an EDAX of samples treated with the inventive medium with sodium borohydride addition.

Figure 22 illustrates an EDAX of samples treated with the inventive medium with sodium borohydride addition and a thermal post treatment.

The instant invention relates to a process for depositing or forming a beneficial surface (e.g., a mineral containing coating or film) upon a metallic surface. The process contacts at least a portion of a metal surface with a silicate medium, e.g., containing soluble mineral components or precursors thereof, having controlled and predetermined silicate concentration, temperature and pH. By “mineral containing coating”, “mineralized film” or “mineral” it is meant to refer to a relatively thin coating or film which is formed upon a metal surface wherein at least a portion of the coating or film comprises at least one metal containing mineral, e.g., an amorphous phase or matrix surrounding or incorporating crystals comprising a zinc disilicate. Mineral and Mineral Containing are defined in the previously identified Cross Reference To Related Patents and Paten Applications; incorporated by reference.

By "metal containing", "metal", or "metallic", it is meant to refer to sheets, shaped articles, fibers, rods, particles, continuous lengths such as coil and wire, metallized surfaces, among other configurations that are based upon at least one metal and alloys including a metal having a naturally occurring, or chemically, mechanically or

5 thermally modified surface. Typically a naturally occurring surface upon a metal will comprise a thin film or layer comprising at least one oxide, hydroxides, carbonates, sulfates, chlorides, among others. The naturally occurring surface can be removed or modified by using the inventive process.

The metal surface refers to a metal article or body as well as a non-metallic
10 member having an adhered metal or conductive layer. While any suitable surface can be treated by the inventive process, examples of suitable metal surfaces comprise at least one member selected from the group consisting of galvanized surfaces, sheradized surfaces, zinc, iron, steel, brass, copper, nickel, tin, aluminum, lead, cadmium, magnesium, alloys thereof such as zinc-nickel alloys, tin-zinc alloys, zinc-cobalt alloys,
15 zinc-iron alloys, among others. If desired, the mineral layer can be formed on a non-conductive substrate having at least one surface coated with a metal, e.g., a metallized polymeric article or sheet, ceramic materials coated or encapsulated within a metal, among others. Examples of metallized polymer comprise at least one member selected from the group of polycarbonate, acrylonitrile butadiene styrene (ABS), rubber, silicone,
20 phenolic, nylon, PVC, polyimide, melamine, polyethylene, polypropylene, acrylic, fluorocarbon, polysulfone, polyphenylene, polyacetate, polystyrene, epoxy, among others. Conductive surfaces can also include carbon or graphite as well as conductive polymers (polyaniline for example).

The metal surface can possess a wide range of sizes and configurations, e.g.,
25 fibers, coils, sheets including perforated acoustic panels, chopped wires, drawn wires or wire strand/rope, rods, couplers (e.g., hydraulic hose couplings), fibers, particles, fasteners (including industrial and residential hardware), brackets, nuts, bolts, rivets, washers, cooling fins, stamped articles, powdered metal articles, among others. The limiting characteristic of the inventive process to treat a metal surface is dependent upon
30 the ability of the surface to be contacted with the inventive silicate medium.

The inventive process can be operated on a batch or continuous basis. The type of process will depend upon the configuration of the metal being treated. The contact time within the silicate medium ranges from about 10 seconds to about 50 minutes and normally about 1 to about 15 minutes. The inventive process can be practiced in any
35 suitable apparatus. Examples of suitable apparatus comprise a batch process performed

5 in polypropylene tanks having means for circulating the silicate medium and maintaining a predetermined temperature.

The silicate containing medium can be a fluid bath, gel, spray, fluidized beds, among other methods for contacting the substrate with the silicate medium. Examples of the silicate medium comprise a bath containing at least one silicate, a gel comprising at
10 least one silicate and a thickener, among others. The medium can comprise a bath comprising at least one of potassium silicate, calcium silicate, lithium silicate, sodium silicate, ammonium silicate, compounds releasing silicate moieties or species, among other silicates. The bath can comprise any suitable polar or non-polar carrier such as water, alcohol, ethers, carboxylic acids, among others. Normally, the bath comprises at
15 least one water-soluble silicate such as sodium silicate and de-ionized water and optionally at least one dopant (e.g. chlorides among other monovalent species). Typically, the at least one dopant is water soluble or dispersible within an aqueous medium.

The silicate containing medium typically has a basic pH. Normally, the pH will
20 range from greater than about 9 to about 13 and typically, about 10 to about 12. The pH of the medium can be monitored and maintained by using conventional detection and delivery methods. The selected detection method should be reliable at relatively high sodium concentrations and under ambient conditions.

The silicate medium is normally aqueous and can comprise at least one water
25 soluble or dispersible silicate in an amount from greater than about 0 to about 40 wt.%, usually, about 1 to 15 wt.% and typically about 3 to 8 wt.%. The amount of silicate in the medium should be adjusted to accommodate silicate sources having differing concentrations of silicate. The silicate containing medium is also normally substantially free of heavy metals, chromates and/or phosphates.

30 The silicate medium can be modified by adding at least one stabilizing compound (e.g., stabilizing by complexing metals). An example of a suitable stabilizing compound comprises phosphines, sodium citrate, ammonium citrate, ammonium iron citrate, sodium salts of ethylene diamine tetraacetic acid (EDTA) and nitrilotriacetic acid (NTA), 8-hydroxylquinoline, 1,2-diaminocyclohexane-tetracetyic acid, diethylene-triamine
35 pentacetic acid, ethylenediamine tetraacetic acid, ethylene glycol bisaminoethyl ether

5 tetraacetic acid, ethyl ether diaminetetraacetic acid, N'-hydroxyethylethylenediamine triacetic acid, 1-methyl ethylene diamine tetraacetic acid, nitriloacetic acid, pentaethylene hexamine, tetraethylene pentamine, triethylene tetraamine, among others.

In one aspect, the silicate medium has a basic pH and comprises at least one water soluble silicate, water and colloidal silica. The silicate medium can also be modified by
10 adding colloidal particles such as colloidal silica (commercially available as Ludox® AM-30, HS-40, among others). The colloidal silica has a particle size ranging from about 10nm to about 50nm. The size of particles in the medium ranges from about 10nm to 1 micron and typically about 0.05 to about 0.2 micron. The medium has a turbidity of about 10 to about 700, typically about 50 to about 300 Nephelometric Turbidity Units
15 (NTU) (as determined in accordance with conventional procedures).

The temperature of the silicate medium can be controlled to optimize the interaction between the medium and a metal surface. Normally, the temperature will range from about 50 to at least about 100C and typically about 50 to 100C (e.g., 55 C). This temperature can be maintained by using conventional heaters and related control
20 systems. If desired, the metal surface can be heated prior to being introduced into the medium.

The chemical and/or physical properties of the silicate medium can be affected by exposing the medium to a source of electrical or magnetic energy. For example, the bath can be exposed to a source of energy such as the electrical current described in
25 aforementioned U.S. Serial No. 09/814,641; hereby incorporated by reference. Such exposure can improve the interaction between the medium and the metal surface, partially polymerize the silicate medium, partially crystallize the silicate medium, among other affects.

The silicate medium can be modified by adding water/polar carrier dispersible or
30 soluble polymers. If utilized, the amount of polymer or water dispersible materials normally ranges from about 0 wt.% to about 10 wt.%. Examples of polymers or water dispersible materials that can be employed in the silicate medium comprise at least one member selected from the group of acrylic copolymers (supplied commercially as Carbopol®), zirconyl ammonium carbonate, hydroxyethyl cellulose, clays such as
35 bentonite, fumed silica, solutions comprising sodium silicate (supplied commercially by

5 MacDermid as JS2030S), among others. A suitable composition can be obtained in an aqueous composition comprising about 3 wt % silicate (obtained from N-grade Sodium Silicate Solution (PQ Corp) that comprises 25% silicate), optionally about 0.5 wt% Carbopol EZ-2 (BF Goodrich), about 5 to about 10 wt.% fumed silica, mixtures thereof, among others.

10 In an aspect of the invention, the silicate medium is modified to include at least one dopant material. The dopants can be useful for building additional thickness of the deposited layer, hydroxides of iron, aluminum, manganese, and magnesium among others. The amount of dopant can vary depending upon the properties of the dopant and desired results. Typically, the amount of dopant will range from about 0.001 wt.% to
15 about 5 wt.% of the medium (or greater so long as the deposition rate is not adversely affected). Examples of suitable dopants comprise at least one member selected from the group of water dispersible or soluble salts, oxides and precursors of tungsten, molybdenum (e.g., molybdenum chloride), titanium (titanates), zircon, vanadium, phosphorus, aluminum (e.g., aluminates, aluminum chloride, etc), iron (e.g., iron
20 chloride), boron (borates), bismuth, cobalt (e.g., cobalt chloride, cobalt oxide, etc.), gallium, tellurium, germanium, antimony, niobium (also known as columbium), magnesium and manganese, nickel (e.g., nickel chloride, nickel oxide, etc.), sulfur, zirconium (zirconates) mixtures thereof, among others, and usually, salts and oxides of aluminum and iron, and hydroxides of iron, aluminum, manganese and magnesium,
25 among others; and other water soluble or dispersible monovalent species. The dopant can comprise at least one of molybdenic acid, fluorotitanic acid and salts thereof such as titanium hydrofluoride, ammonium fluorotitanate, ammonium fluorosilicate and sodium fluorotitanate; fluorozirconic acid and salts thereof such as H_2ZrF_6 , $(NH_4)_2ZrF_6$ and Na_2ZrF_6 ; among others. Alternatively, dopants can comprise at least one substantially
30 water insoluble material such as electrophoretic transportable polymers, PTFE, boron nitride, silicon carbide, silicon nitride, aluminum nitride, titanium carbide, diamond, titanium diboride, tungsten carbide, silica (e.g., colloidal silica available commercially as Ludox® AM and HS) metal oxides such as cerium oxide, powdered metals and metallic precursors such as zinc, among others.

5 If desired, the dopant can be dissolved or dispersed without another medium prior to introduction into the silicate medium. For example, at least one dopant can be combined with a basic compound, e.g., sodium hydroxide, and then added to the silicate medium. Examples of dopants that can be combined with another medium comprise zirconia, cobalt oxide, nickel oxide, molybdenum oxide, titanium (IV) oxide, niobium
10 (V) oxide, magnesia, zirconium silicate, alumina, antimony oxide, zinc oxide, zinc powder, aluminum powder, among others.

The aforementioned dopants that can be employed for enhancing mineral layer formation rate, modifying the chemistry and/or physical properties of the resultant layer, as a diluent for the silicate containing medium, among others. Examples of such dopants
15 are iron salts (ferrous chloride, sulfate, nitrate), aluminum fluoride, fluorosilicates (e.g., K_2SiF_6), fluoroaluminates (e.g., potassium fluoroaluminate such as $K_2AlF_5 \cdot H_2O$), mixtures thereof, among other sources of metals and halogens. The dopant materials can be introduced to the metal surface in pretreatment steps, in post treatment steps (e.g., rinse), and/or by alternating exposing the metal surface to solutions of dopants and
20 solutions of silicates if the silicates will not form a stable solution with the dopants, e.g., one or more water soluble dopants. The presence of dopants in the silicate medium can be employed to form tailored surfaces upon the metal, e.g., an aqueous sodium silicate solution containing aluminate can be employed to form a layer comprising oxides of silicon and aluminum. That is, at least one dopant (e.g., zinc) can be co-deposited along
25 with at least one siliceous species (e.g., a mineral) upon the substrate.

The silicate medium can also be modified by adding at least one diluent. Examples of suitable diluent comprise at least one member selected from the group of sodium sulphate, surfactants, de-foamers, colorants/dyes, conductivity modifiers, among others. The diluent (e.g., sodium sulfate) can be employed for reducing the affects of
30 contaminants entering the silicate medium, reducing bath foam, among others. When the diluent is employed as a defoamer, the amount normally comprises less than about 5 wt.% of the medium, e.g., about 1 to about 2 wt.%.

According to one embodiment of the invention, the silicate medium further comprises at least one reducing agent. An example of a suitable reducing agent
35 comprises sodium borohydride, phosphorus compounds such as hypophosphide

5 compounds, phosphate compounds, among others. Without wishing to be bound by any theory or explanation, it is believed that the reducing agent may reduce water present in the silicate medium thereby modifying the surface pH of articles that contact the silicate medium (e.g., article may induce or catalyze activity of the reducing agent). According to one embodiment, the concentration of sodium borohydride is typically 1 gram per liter
10 of bath solution to about 20 grams per liter of bath solution more typically 5 grams per liter of bath solution to about 15 gram per liter of bath solution. In one illustrative and preferred embodiment, 10 grams of sodium borohydride per liter of bath solution is utilized. When employed the reducing agent, can cause hydrogen evolution once the bath/medium has been sufficiently heated.

15 Contact with the inventive silicate medium can be preceded by and/or followed with conventional pre-treatments and/or post-treatments known in this art such as cleaning or rinsing, e.g., immersion/spray within the treatment, sonic cleaning, double counter-current cascading flow; alkali or acid treatments, among other treatments. By employing a suitable post-treatment the solubility, corrosion resistance (e.g., reduced
20 white rust formation when treating zinc containing surfaces), sealer and/or topcoat adhesion, among other properties of surface of the substrate formed by the inventive method can be improved. If desired, the post-treated surface can be sealed, rinsed and/or topcoated, e.g., silane, epoxy, latex, fluoropolymer, acrylic, titanates, zirconates, carbonates, urethanes, among other coatings.

25 In one aspect of the invention, a pre-treatment comprises exposing the substrate to be treated to at least one of an acid, base (e.g., zincate solution), oxidizer, among other compounds. The pre-treatment can be employed for cleaning oils, removing excess oxides or scale, equipotentialize the surface for subsequent mineralization treatments, convert the surface into a mineral precursor, functionalize the surface (e.g., a
30 hydroxylized surface), among other benefits. Conventional methods for acid cleaning metal surfaces are described in ASM, Vol. 5, Surface Engineering (1994), and U.S. Patent No. 6,096,650; hereby incorporated by reference.

In one aspect of the invention, the metal surface is pre-treated or cleaned electrolytically by being exposed to an anodic environment. That is, the metal surface is
35 exposed to the silicate medium wherein the metal surface is the anode and a current is

5 introduced into the medium. By using the metal as the anode in a DC cell and maintaining a current of about 10A/ft² to about 150A/ft², the process can generate oxygen gas. The oxygen gas agitates the surface of the workpiece while oxidizing the substrate's surface. The surface can also be agitated mechanically by using conventional vibrating equipment. If desired, the amount of oxygen or other gas present during
10 formation of the mineral layer can be increased by physically introducing such gas, e.g., bubbling, pumping, among other means for adding gases.

If desired, the inventive method can include a thermal post-treatment. The metal surface can be removed from the silicate medium, dried (e.g., at about 100 to 150C for about 2.5 to 10 minutes), rinsed in deionized water and then dried in order to remove
15 rinse water. This is in contrast to conventional metal treatments that rinse(s) and then dry. The dried surface may be processed further as desired; e.g. contacted with a sealer, rinse or topcoat. If desired, the rinse can comprise a reactive component such as a silane, carbonate, zirconate, colloidal silica, among other compounds that interact with the treated metallic surface.

20 In aspect of the invention, the thermal post treatment comprises heating the surface. Typically the amount of heating is sufficient to consolidate or densify the inventive surface without adversely affecting the physical properties of the underlying metal substrate. Heating can occur under atmospheric conditions, within a nitrogen containing environment, among other gases. Alternatively, heating can occur in a
25 vacuum. The surface may be heated to any temperature within the stability limits of the surface coating and the surface material. Typically, surfaces are heated from about 75° C to about 250° C, more typically from about 150° C to about 200° C. If desired, the heat treated component can be rinsed in water to remove any residual water soluble species and then dried again (e.g., at a temperature and time sufficient to remove water).

30 If desired, prior to heating the inventive surface can be contacted with a solution containing a material that reacts with the surface at elevated temperatures, e.g., a eutectic formed between silica and at least one of Al₂O₃, B₂O₃, Fe₂O₃, MgO, phosphates, among others. Normally, the heating will be sufficient to cause sintering or a desirable interaction without adversely affecting the underlying metal. Alternatively or in addition

5 to heating, the metal surface can be exposed to an atmosphere having controlled pressure in order to tailor the treated surface.

In one aspect of the invention, a post treatment comprises exposing the substrate to a source of at least one carbonate or precursors thereof. Examples of carbonate comprise at least one member from the group of gaseous carbon dioxide, lithium carbonate, lithium bicarbonate, sodium carbonate, sodium bicarbonate, potassium
10 carbonate, potassium bicarbonate, rubidium carbonate, rubidium bicarbonate, rubidium acid carbonate, cesium carbonate, ammonium carbonate, ammonium bicarbonate, ammonium carbamate and ammonium zirconyl carbonate. Normally, the carbonate source will be water soluble. In the case of a carbonate precursor such as carbon dioxide,
15 the precursor can be passed through a liquid (including the silicate containing medium) and the substrate immersed in the liquid. One specific example of a suitable posttreatment is disclosed in U.S. Patent No. 2,462,763; hereby incorporated by reference. Another specific example of a post treatment comprises exposing a treated surface to a solution obtained by diluting ammonium zirconyl carbonate (1:4) in distilled water (e.g., Bacote®
20 20 supplied by Magnesium Elektron Corp). If desired, this post treated surface can be topcoated (e.g., aqueous or water borne topcoats).

In another aspect of the invention, the post treatment comprises exposing the substrate to a source comprising at least one acid source or precursors thereof. Examples of suitable acid sources comprise at least one member chosen from the group of
25 phosphoric acid, hydrochloric acid, molybdic acid, silicic acid, acetic acid, citric acid, nitric acid, hydroxyl substituted carboxylic acid, glycolic acid, lactic acid, malic acid, tartaric acid, ammonium hydrogen citrate, ammonium bifluoride, fluoboric acid, fluorosilicic acid, among other acid sources effective at improving at least one property of the treated metal surface. The pH of the acid post treatment may be modified by
30 employing at least one member selected from the group consisting of ammonium citrate dibasic (available commercially as Citrosol® #503 and Multiprep®), fluoride salts such as ammonium bifluoride, fluoboric acid, fluorosilicic acid, among others. The acid post treatment can serve to activate the surface thereby improving the effectiveness of rinses, sealers and/or topcoatings (e.g., surface activation prior to contacting with a sealer can
35 improve cohesion between the surface and the sealer thereby improving the corrosion

5 resistance of the treated substrate). Normally, the acid source will be water soluble and employed in amounts of up to about 15 wt.% and typically, about 1 to about 5 wt.% and have a pH of less than about 5.5.

In another aspect of the invention, the post treatment comprises contacting a surface treated by the inventive process with a rinse. By "rinse" it is meant that an article
10 or a treated surface is sprayed, dipped, immersed or other wise exposed to the rinse in order to affect the properties of the treated surface. For example, a surface treated by the inventive process is immersed in a bath comprising at least one rinse. In some cases, the rinse can interact or react with at least a portion of the treated surface. Further the rinsed surfaced can be modified by multiple rinses, heating, topcoating, adding dyes, lubricants
15 and waxes, among other processes. Examples of suitable compounds for use in rinses comprise at least one member selected from the group of titanates, titanium chloride, tin chloride, zirconates, zirconium acetate, zirconium oxychloride, fluorides such as calcium fluoride, tin fluoride, titanium fluoride, zirconium fluoride; coppurous compounds, ammonium fluorosilicate, metal treated silicas (e.g., Ludox®), combinations comprising
20 colloidal silica, nitrates such as aluminum nitrate; sulphates such as magnesium sulphate, sodium sulphate, zinc sulphate, silanes, siloxyanes, siloxyenes, and copper sulphate; lithium compounds such as lithium acetate, lithium bicarbonate, lithium citrate, lithium metaborate, lithium vanadate, lithium tungstate, among others. The rinse can further comprise at least one organic compound such as vinyl acrylics, fluorosurfactants,
25 polyethylene wax, TEOS, zirconyl ammonium carbonate, among others. Examples of commercially available rinses, sealers and topcoats comprise at least one member selected from the group of Aqualac® (urethane containing aqueous solution), W86®, W87®, B37®, T01®, E10®, B17, B18 among others (a heat cured coating supplied by the Magni® Group), JS2030S (sodium silicate containing rinse supplied by MacDermid Incorporated), JS2040I (a molybdenum containing rinse also supplied by MacDermid Incorporated), EnSeal® C-23 (an acrylic based coating supplied by Enthone), EnSeal® C-26, Enthone® C-40 (a pigmented coating supplied Enthone), Microseal®, Paraclene® 99 (a chromate containing rinse), EcoTri® (a silicate/polymer rinse), MCI Plus OS (supplied by Metal Coatings International), silanes (e.g., Dow Corning Z-6040, Gelest
35 SIA 0610.0, among others), ammonium zirconyl carbonate (e.g., Bacote 20), urethanes

5 (e.g., Agate L18), among others. One specific rinse comprises water, water dispersible urethane, and at least one silicate, e.g., refer to commonly assigned U.S. Patent No. 5,871,668; hereby incorporated by reference. While the rinse can be employed neat, normally the rinse will be dissolved, diluted or dispersed within another medium such as water, organic solvents, among others. While the amount of rinse employed depends
10 upon the desired results, normally the rinse comprises about 0.1wt% to about 50 wt.% of the rinse medium. The rinse can be employed as multiple applications and, if desired, heated. The rinse can be employed after a thermal treatment, e.g., after removing from the silicate medium the part is dried and then rinsed. Moreover, the aforementioned rinses can be modified by incorporating at least one dopant, e.g. the aforementioned
15 dopants. The dopant can employed for interacting or reacting with the treated surface. If desired, the dopant can be dispersed in a suitable medium such as water and employed as a rinse.

The inventive process can create a flexible surface that can survive secondary processes, e.g., metal deformation for riveting, swaging, crimping, among other
20 processes, and continue to provide corrosion protection. Such is in contrast to typical corrosion inhibitors such as chromates that tend to crack when the underlying surface is shaped. If desired, the surface formed by the inventive process can be topcoated (e.g, with a heat cured epoxy), prior to secondary processing. Articles treated in accordance with the inventive process, topcoated and exposed to a secondary process retain their
25 desirable corrosion resistance, coating adhesion, component functionality, among properties.

The inventive process can provide a surface (e.g., mineral coating) that can enhance the surface characteristics of the metal or conductive surface such as resistance to corrosion, protect carbon (fibers for example) from oxidation, stress crack corrosion
30 (e.g., stainless steel), hardness, thermal resistance, improve bonding strength in composite materials, provide dielectric layers, improve corrosion resistance of printed circuit/wiring boards and decorative metal finishes, and reduce the conductivity of conductive polymer surfaces including application in sandwich type materials.

The mineral coating can also affect the electrical and magnetic properties of the
35 surface. That is, the mineral coating can impart electrical resistance or insulative

5 properties to the treated surface. By having an electrically non-conductive surface, articles having the inventive layer can reduce, if not eliminate, electro-galvanic corrosion in fixtures wherein current flow is associated with corrosion, e.g., bridges, pipelines, among other articles.

Depending upon the intended usage of the workpiece treated by the inventive
10 method, the workpiece can be coated with a secondary coating or layer. Alternatively, the treated workpiece can be rinsed (as described above) and then coated with a secondary coating or layer. Examples of such secondary coatings or layers comprise one or more members of acrylic coatings (e.g., IRILAC®), e-coats, silanes including those having amine, acrylic and aliphatic epoxy functional groups, latex, urethane, epoxies,
15 silicones, alkyds, phenoxy resins (powdered and liquid forms), radiation curable coatings (e.g., UV curable coatings), lacquer, shellac, linseed oil, among others. Secondary coatings can be solvent or water borne systems. Secondary coatings can also include corrosion inhibitors, torque tension modifiers, among other additives (e.g., a coating comprising urethanes, acrylics, corrosion inhibitor and sodium silicate). The secondary
20 coatings can be applied by using any suitable conventional method such as immersing, dip-spin, spraying, among other methods. The secondary coatings can be cured by any suitable method such as UV exposure, heating, allowed to dry under ambient conditions, among other methods. An example of UV curable coating is described in U.S. Patent Nos. 6,174,932 and 6,057,382; hereby incorporated by reference. Normally, the surface
25 formed by the inventive process will be rinsed, e.g., with at least one of deionized water, silane or a carbonate, or subjected to a thermal treatment (e.g., removal from the silicate bath, dried and then rinsed to remove residual material), prior to applying a topcoat. The secondary coatings can be employed for imparting a wide range of properties such as improved corrosion resistance to the underlying mineral layer, reduce torque tension, a
30 temporary coating for shipping the treated workpiece, decorative finish, static dissipation, electronic shielding, hydrogen and/or atomic oxygen barrier, among other utilities. The mineral coated metal, with or without the secondary coating, can be used as a finished product or a component to fabricate another article.

The thickness of the rinse, sealer and/or topcoat can range from about 0.00001
35 inch to about 0.025 inch. The selected thickness varies depending upon the end use of

5 the coated article. In the case of articles having close dimensional tolerances, e.g., threaded fasteners, normally the thickness is less than about 0.00005 inch.

Without wishing to be bound by any theory or explanation a silica containing layer can be formed. By silica it is meant a framework of interconnecting molecular silica such as SiO₄ tetrahedra (e.g., amorphous silica, cristobalite, trypmite, quartz, among
10 other morphologies depending upon the degree of crystallinity), monomeric or polymeric species of silicon and oxide, monomeric or species of silicon and oxide embedding colloidal species, among others. The crystallinity of the silica can be modified and controlled depending upon the conditions under which the silica is deposited, e.g., temperature and pressure. The silica containing layer may comprise: 1) low porosity
15 silica (e.g., about 60 angstroms to 0.5 microns in thickness), 2) colloidal silica (e.g., about 50 angstroms to 0.5 microns in thickness), 3) a mixture comprising 1 and 2, 4) residual silicate such as sodium silicate and in some cases combined with 1 and 2; and 5) monomeric or polymeric species optionally embedding other colloidal silica species such as colloidal silica. The formation of a silica containing layer can be enhanced by the
20 addition of colloidal particles to the silicate medium. An example of suitable colloidal particles comprise colloidal silica having a size of at least about 12 nanometers to about 0.1 micron (e.g., Ludox® HS 40, AM 30, and CL). The colloidal silica can be stabilized by the presence of metals such as sodium, aluminum/alumina, among others.

If desired, the silica containing film or layer can be provided in as a secondary
25 process. That is, a first film or layer comprising a disilicate can be formed upon the metallic surface and then a silica containing film or layer is formed upon the disilicate surface. An example of this process is described in U.S. Patent Application Serial No. 60/354,565, filed on February 05, 2002 and entitled "Method for Treating Metallic Surfaces"; the disclosure of which is hereby incorporated by reference.

30 The silica containing layer can be chemically or physically modified and employed as an intermediate or tie-layer. The tie-layer can be used to enhance bonding to paints, coatings, metals, glass, among other materials contacting the tie-layer. This can be accomplished by binding to the top silica containing layer one or more materials which contain alkyl, fluorine, vinyl, epoxy including two-part epoxy and powder paint
35 systems, silane, hydroxy, amino, mixtures thereof, among other functionalities reactive to

5 silica or silicon hydroxide. Alternatively, the silica containing layer can be removed by using conventional cleaning methods, e.g. rinsing with de-ionized water, or one of the aforementioned post-treatments, e.g. acid rinsing. If desired, the silica containing layer can be chemically and/or physically modified by employing the previously described post-treatments, e.g., exposure to at least one carbonate or acid source. The post-treated
10 surface can then be contacted with at least one of the aforementioned secondary coatings, e.g. a heat cured epoxy.

In another aspect, the mineral without or without the aforementioned silica may layer functions as an intermediate or tie-layer for one or more secondary coatings, e.g., silane containing secondary coatings. Examples of such secondary coatings and methods
15 that can be complimentary to the instant invention are described in U.S. Patent Nos. 5,759,629; 5,750,197; 5,539,031; 5,498,481; 5,478,655; 5,455,080; and 5,433,976. The disclosure of each of these U.S. Patents is hereby incorporated by reference. For example, improved corrosion resistance of a metal substrate can be achieved by using a secondary coating comprising at least one suitable silane in combination with a
20 mineralized surface. Examples of suitable silanes comprise at least one members selected from the group consisting of tetraethylorthosilicate (TEOS) and TMOS with styrene, and etc., bis-1,2-(triethoxysilyl) ethane (BSTE), vinyl silane or aminopropyl silane, epoxy silanes, alkoxysilanes, methacryloxypropyl trimethoxysilanes, glycidoxypopyl trimethoxysilane, vinyltriactoxysilane, among other organo functional
25 silanes. The silane can bond with the mineralized surface and then the silane can cure thereby providing a protective top coat, or a surface for receiving an outer coating or layer. In some cases, it is desirable to sequentially apply the silanes. For example, a steel substrate, e.g., a fastener, can be treated by the inventive process to form a mineral layer, allowed to dry, rinsed in deionized water, coated with a 5% BSTE solution, coated again
30 with a 5% vinyl silane solution, and powder coated with a thermoset epoxy paint (Corvel 10-1002 by Morton) at a thickness of 2 mils.

The inventive process forms a surface that has improved adhesion to outer coatings or layers, e.g., secondary coatings. Examples of suitable outer coatings comprise at least one member selected from the group consisting of acrylics, epoxies, e-
35 coats, latex, urethanes, silanes (e.g., TEOS, TMEOS, among others), fluoropolymers,

5 alkyds, silicones, polyesters, oils, gels, grease, among others. An example of a suitable epoxy comprises a coating supplied by The Magni® Group as B17 or B18 top coats, e.g., a galvanized article that has been treated in accordance with the inventive method and contacted with at least one silane and/or ammonium zirconium carbonate and top coated with a heat cured epoxy (Magni® B18) thereby providing a chromate free corrosion
10 resistant article. By selecting appropriate rinses, secondary and outer coatings for application upon the mineral, a corrosion resistant article can be obtained without chromating or phosphating. Such a selection can also reduce usage of zinc to galvanize iron containing surfaces, e.g., a steel surface is mineralized, coated with a silane containing coating and with an outer coating comprising an epoxy.

15 Without wishing to be bound by any theory or explanation, it is believed that the inventive process forms a surface that can release or provide water or related moieties. These moieties can participate in a hydrolysis or condensation reaction that can occur when an overlying rinse, seal or topcoating cures. Such participation improves the cohesive bond strength between the surface and overlying cured coating.

20 The surface formed by the inventive process can also be employed as an intermediate or tie-layer for glass coatings, glass to metal seals, hermetic sealing, among other applications wherein it is desirable to have a joint or bond between a metallic substrate and a glass layer or article. The inventive surface can serve to receive molten glass (e.g., borosilicate, aluminosilicate, phosphate, among other glasses), while
25 protecting the underlying metallic substrate and forming a seal.

The surface formed by the inventive process can also be employed as a heat resistant surface. The surface can be employed to protect an underlying surface from exposure to molten metal (e.g., molten aluminum).

The inventive process can provide a surface that improves adhesion between a
30 treated substrate and an adhesive. Examples of adhesives comprise at least one member selected from the group consisting of hot melts such as at least one member selected from the group of polyamides, polyimides, butyls, acrylic modified compounds, maleic anhydride modified ethyl vinyl acetates, maleic anhydride modified polyethylenes, hydroxyl terminated ethyl vinyl acetates, carboxyl terminated ethyl vinyl acetates, acid
35 terpolymer ethyl vinyl acetates, ethylene acrylates, single phase systems such as

5 dicyanamide cure epoxies, polyamide cure systems, lewis acid cure systems, polysulfides, moisture cure urethanes, two phase systems such as epoxies, activated acrylates polysulfides, polyurethanes, among others. Two metal substrates having surfaces treated in accordance with the inventive process can be joined together by using an adhesive. Alternatively one substrate having the inventive surface can be adhered to another
10 material, e.g., joining treated metals to plastics, ceramics, glass, among other surfaces. In one specific aspect, the substrate comprises an automotive hem joint wherein the adhesive is located within the hem.

The improved cohesive and adhesive characteristics between a surface formed by the inventive process and polymeric materials can permit forming acoustical and
15 mechanical dampeners, e.g., constraint layer dampers such as described in U.S. Patent No. 5,678,826 hereby incorporated by reference, motor mounts, bridge/building bearings, HVAC silencers, highway/airport sound barriers, among other articles. The ability to improve the bond between viscoelastic materials sandwiched between metal panels in dampers reduces sound transmission, improves formability of such panels, reduces
20 process variability, among other improvements. The metal panels can comprise any suitable metal such as 304 steel, stainless steel, aluminum, cold rolled steel, zinc alloys, hot-dipped zinc or electrogalvanized, among other materials. Examples of polymers that can be bonded to the inventive surface and in turn to an underlying metal substrate comprise any suitable material such as neoprene, EPDM, SBR, EPDM, among others.
25 The inventive surface can also provide elastomer to metal bonds described in U.S. Patent No. 5,942,333; hereby incorporated by reference.

The inventive process can employ dopants, rinses, sealers and/or topcoats for providing a surface having improved thermal and wear resistance. Such surfaces can be employed in gears (e.g., transmission), powdered metal articles, exhaust systems
30 including manifolds, metal flooring/grates, heating elements, among other applications wherein it is desirable to improve the resistance of metallic surfaces.

In another aspect of the invention, the inventive process can be used to produce a surface that reduces, if not eliminates, molten metal adhesion (e.g., by reducing intermetallic formation). Without wishing to be bound by any theory or explanation, it is
35 believed that the inventive process provides an ablative and/or a reactive film or coating

5 upon an article or a member that can interact or react with molten metal thereby reducing
adhesion to the bulk article. For example, the inventive process can provide an iron or a
zinc silicate film or layer upon a substrate in order to shield or isolate the substrate from
molten fluid contact (e.g., molten glass, aluminum, zinc or magnesium). The
effectiveness of the film or layer can be improved by applying an additional coating
10 comprising silica (e.g., to function as an ablative when exposed to molten metal or glass).
The ability to prevent molten metal adhesion is desirable when die casting aluminum or
magnesium over zinc cores, die casting aluminum for electronic components, among
other uses. The molten metal adhesion can be reduced further by applying one of the
aforementioned topcoatings, e.g. Magni® B18, acrylics, polyesters, among others. The
15 topcoatings can be modified (e.g., to be more heat resistant, or reactive to alumina or
aluminum) by adding a heat resistant material such as colloidal silica (e.g., Ludox®).

While the above description places particular emphasis upon forming a mineral
containing layer upon a metal surface, the inventive process can be combined with or
replace conventional metal pre or post treatment and/or finishing practices. Conventional
20 post coating baking methods can be employed for modifying the physical characteristics
of the mineral layer, remove water and/or hydrogen, among other modifications. The
inventive mineral layer can be employed to protect a metal finish from corrosion thereby
replacing conventional phosphating process, e.g., in the case of automotive metal
finishing the inventive process could be utilized instead of phosphates and chromates and
25 prior to coating application e.g., E-Coat. The inventive process can be employed for
imparting enhanced corrosion resistance to electronic components. The inventive process
can also be employed in a virtually unlimited array of end-uses such as in conventional
plating operations as well as being adaptable to field service. For example, the inventive
mineral containing coating can be employed to fabricate corrosion resistant metal
30 products that conventionally utilize zinc as a protective coating, e.g., automotive bodies
and components, grain silos, bridges, among many other end-uses. Moreover, depending
upon the dopants and concentration thereof present in the mineral deposition solution, the
inventive process can produce microelectronic films, e.g., on metal or conductive
surfaces in order to impart enhanced electrical/magnetic (e.g., EMI shielding, reduced
35 electrical connector fretting, reduce corrosion caused by dissimilar metal contact, among

5 others), and corrosion resistance, or to resist ultraviolet light and monatomic oxygen containing environments such as outer space.

The following Examples are provided to illustrate certain aspects of the invention and it is understood that such an Example does not limit the scope of the invention.

10

EXAMPLE 1

The effect on the deposit characteristics of the following parameters were studied: (i) pH of bath, (ii) temperature of deposition, and (iii) rinsing immediately or after one day. Subsequent to deposition, impedance analysis and linear polarization were used to electrochemically characterize the final deposit.

15

The base silicate medium solution comprised 800 mL of distilled water + 100 mL of PQ N Sodium Silicate solution (hereinafter referred to as 1:8 sodium: silicon solution). The PQ N Sodium Silicate solution is 8.9 wt % Na_2O and 28.7 wt % SiO_2 . The deposition was carried out in a plating cell made of glass on ACT zinc plated steel panels. Prior to deposition the panels were degreased with acetone and washed with demineralized water. Two different sets of parameters were varied in this experiment:

20

- First, the effect of pH was studied at 75°C at 10.5, 10.8, 11, 11.5 and 12.
- Next, the effect of temperature was studied at 75°C, 80°C and 85°C.

For both studies, the immersion time was held constant at 15 minutes. Subsequent to mineralization one set of panels was rinsed immediately. The second set of samples were rinsed after 24 hours before carrying out the measurements.

25

Next, the corrosion characteristics of the panel were studied in 0.5 M Na_2SO_4 solution at pH 4. A representative panel area of 1 cm^2 was chosen for testing. A three-electrode setup was used to study the corrosion behavior of the mineralized samples. The electrolyte used in this study is 0.5 M sodium sulfate, pH=4. Ti coated with Pd was used as the counter electrode. $\text{Hg}/\text{Hg}_2\text{SO}_4$ was used as the reference electrode. All potentials in this study are referred with respect to the $\text{Hg}/\text{Hg}_2\text{SO}_4$ electrode. Corrosion studies were done using Scribner Associates Corrware Software with EG&G Princeton applied Model 273 potentiostat/galvanostat and a Solartron 1255 frequency analyzer in accordance with conventional methods. The electrode was left on open circuit till the potential is stabilized. After the potential stabilized, non-destructive evaluation of the surface was

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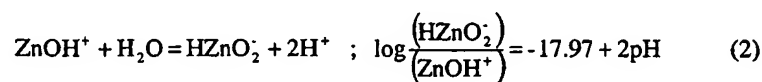
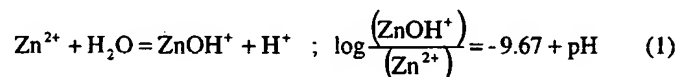
5 done using linear polarization and impedance analysis. During linear polarization, the potential was varied 10 mV above and below the open circuit potential of the mineralized sample at a scan rate of 0.1667 mV/s. The impedance data generally covered a frequency range of 5 mHz to 10 kHz. A sinusoidal ac voltage signal varying by ± 10 mV was applied. The electrode was stable during the experiments and its open circuit potential
10 changed less than 1 mV.

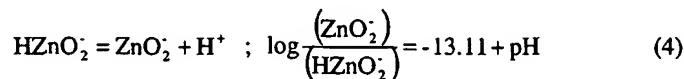
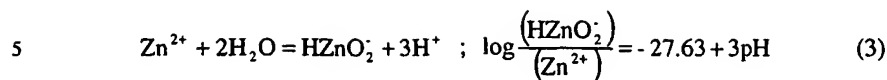
In moderately alkaline solutions (pH <10.5) zinc forms passive films which reduce the rate of metal dissolution. Increasing the pH above 10.5 has a tendency to dissolve the passive film and active metal corrosion. Fig.1 presents the open-circuit potential of galvanized zinc panels immersed in the base solution of pH 10.5. As seen
15 from the plot, the potential initially increases from an initial value of around -0.49 V to more positive values. This indicates the formation of a passive film on the surface of zinc in presence of the base solution.

Fig. 2 shows the potential of galvanized steel in the base solution, pH=11 as a function of time. As shown in Fig. 2, the potential is more negative than that seen in Fig. 1 indicating formation of a relatively less stable film than the film formed at pH=10.5. However the observed potential of -0.7 V vs Hg/HgO reference electrode still indicates a
20 passive film formation on Zn surface in presence of silicate solution even at pH=11.

Increasing the pH further to 11.5, can reduce the effectiveness of the inventive process (see Fig. 3). Note that the corrosion potential increases up to -1.38 V vs
25 Hg/HgSO₄ reference electrode which is dissolution potential for Zn.

According to Pourbaix (Pourbaix, M.: Atlas of Electrochemical Equilibria in Aqueous Solutions, 2nd ed., National Association of Corrosion Engineers, Houston, pp. 406-413, 1974; hereby incorporated by reference), zinc exists in the various forms in solution, some of which are given below. The various equilibrium reactions between the dissolved
30 substances are as follows:





With the increase in pH, the equilibrium is shifted to the right in all the above reactions. For reaction (2) and (3) the effect is more because of the greater dependence on H^+ concentration. Between pH 8.98 and 13.11 HZnO_2^- dominates. Beyond this ZnO_2^{2-} is present.

This Example illustrate that increasing beyond a certain level the pH decreases the chances for the formation of a passive film.

At pH 12 (Fig. 4) corrosion increases and the metal potential fluctuates significantly. Increasing the pH of the silicate medium beyond about 11 can cause active dissolution of the zinc leading to decreasing the protective zinc layer thickness. Increasing the temperature is seen to accelerate the rate of metal dissolution. Similar behavior is observed for pure Zn samples.

Fig. 5 and Fig. 6 summarizes the corrosion potentials determined on galvanized steel samples in base solution at 75° and 80°C, respectively. The corrosion potentials are shown as a function of time estimated in solutions with pH 10.5, 11, 11.5 and 12. The results indicated that at pH 10.5 at 75°C and 80°C passive film forms which is stable as a function of time. Note that increasing the temperature from 75 to 80°C, the potentials estimated at pH=10.5 and 11 shifts for approximately 200 mV in cathodic direction indicating a higher probability for a decrease of the coating barrier properties.

Fig. 7 shows the open circuit potential studies for Zn plated steel at different pHs (10.5, 11 and 12) in the absence of base solutions. As expected the relatively high corrosion potentials (higher than -1.0 V v. Hg/HgSO_4 reference electrode) were observed in the absence of silica in the solution indicating a high probability for Zn dissolution at pH 10.5 and higher

Tables 1 and 2 summarize the polarization resistance data of samples treated in accordance with the inventive mineralization process and tested at different temperatures and pH's (10.5, 10.8, 11, 11.5 and 12). Subsequent to mineralization one set of panels

- 5 was rinsed immediately. The second set of samples was rinsed after 24 hours before carrying out the measurements. The rinsed panels data are presented in Table 1, while the data obtained from panels rinsed after 24 hours are presented in Table 2. In general the samples rinsed after 24 hours showed higher resistances. Increase in temperature from 75°C to 80°C leads to an increase in resistance. In contrast increasing the pH from 10.5 to 12 leads to a decrease in average resistance.
- 10

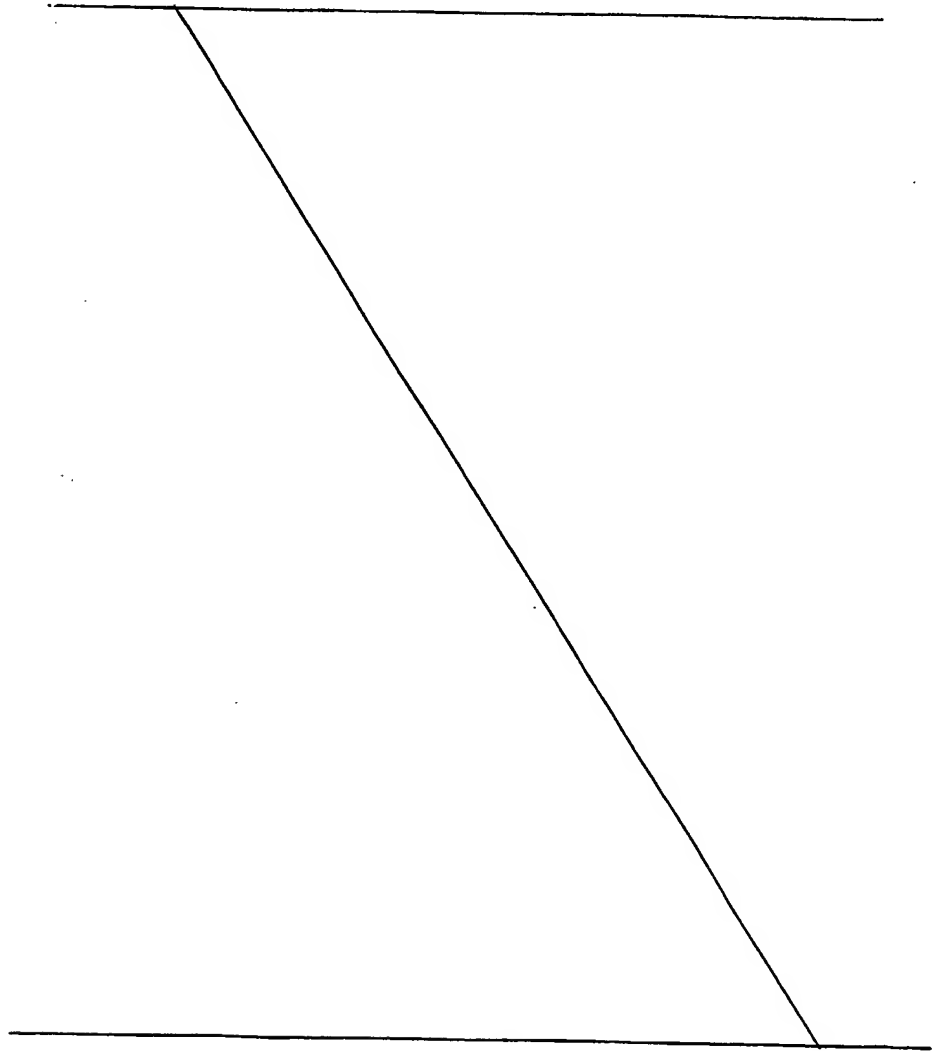


Table 1: No Current Data for temperatures 75, 80, and 85 °C - Rinse

75°C					
0.5 M Na ₂ SO ₄					
pH	10.5	10.8	11	11.5	12
Rp (Ω)	586	2060	712	584	410
Rp (Ω)	697	1318	896	595	422
Rp (Ω)	948	1429	686	183	404
Rp (Ω)	840	1231	609	801	473
Rp (Ω)	858		799	916	609
Rp (Ω)	996		826	1441	931
Average	821	1510	755	753	542

80°C					
0.5 M Na ₂ SO ₄					
pH	10.5	10.8	11	11.5	12
Rp (Ω)	1072	1227	1219	849	731
Rp (Ω)	963	892	1252	719	710
Rp (Ω)	540	1346	1526	830	778
Rp (Ω)	1319	2010	1301	624	905
Rp (Ω)	2203		1079	975	1050
Rp (Ω)	3342		1951	998	898
Average	1573	1369	1388	833	845

85°C				
0.5 M Na ₂ SO ₄				
pH	10.5	10.8	11	11.5
Rp (Ω)	249	1115	1887	783
Rp (Ω)	519	1323	2080	1268
Rp (Ω)	1078	1124	2133	1486
Rp (Ω)	1429	926	1603	1225
Rp (Ω)		1855		
Rp (Ω)		757		
Rp (Ω)		586		
Rp (Ω)		817		
Average	819	1063	1926	1191

Table 2: No Current Data for temperatures 75, 80, and 85 °C - RINSED AFTER 24 HOURS

75°C					
	0.5 M Na ₂ SO ₄				
pH	10.5	10.8	11	11.5	12
Rp (Ω)	1136	1757	1000	712	766
Rp (Ω)	846	1229	1295	727	592
Rp (Ω)	1223	1649	1327	641	950
Rp (Ω)	921	1423	983	1133	1044
Rp (Ω)	1458		4092	1624	1483
Rp (Ω)	3465		2509	2159	2106
Average	1508	1515	1868	1166	1157

80°C					
	0.5 M Na ₂ SO ₄				
pH	10.5	10.8	11	11.5	12
Rp (Ω)	793	983	1715	2564	804
Rp (Ω)	1490	989	1320	2809	931
Rp (Ω)	1418	1094	1874	2792	563
Rp (Ω)	1541	1085	1476	1973	509
Rp (Ω)	3565		2236	7370	982
Rp (Ω)	1545		12413	1265	4904
Average	1725	1038	3506	3129	1449

85°C				
	0.5 M Na ₂ SO ₄			
pH	10.5	10.8	11	11.5
Rp (Ω)	785	729	941	1154
Rp (Ω)	810	1050	883	1169
Rp (Ω)	638	1457	992	1041
Rp (Ω)	648	1577	7996	3769
Rp (Ω)		1197		
Rp (Ω)		519		
Rp (Ω)		739		
Rp (Ω)		957		
Average	720	1028	2703	1783

EXAMPLE 2

A 1:8 (alkali to silica ratio) sodium silicate solution was prepared as described in Example 1. The effect of deposition time, the pH of the silicate medium and the temperature of the silicate medium were studied. Prior to deposition the panels were degreased with acetone and washed with demineralized water. The experiments were performed in duplicate. One set of panels was rinsed immediately following deposition and a second set was rinsed 24 hours later. The corrosion characteristics of the panels were tested in 0.5 M Na₂SO₄ solution at pH 4. A representative panel area of 1 cm² was tested. The rest of the panel was masked with an insulating tape. A three-electrode setup was used to study the corrosion behavior of the mineralized samples. Titanium coated with palladium was used as the counter electrode and Hg/Hg₂Cl₂ was used as the reference electrode. All potentials are with respect to the Saturated Calomel electrode. Corrosion studies were done using a Scribner Associates Corrware Software with EG&G Princeton Applied Research Model 273 potentiostat/galvanostat and a Solartron 1255 frequency analyzer in accordance with conventional procedures. The electrode was left on open circuit until the potential stabilized. Non-destructive evaluation of the surface was done using linear polarization and impedance analysis. During linear polarization, the potential was varied 10 mV above and below the open circuit potential of the mineralized sample at a scan rate of 0.1667 mV/s. The impedance data generally covered a frequency range of 5 mHz to 10 kHz. A sinusoidal AC voltage signal varying by +/- 10mV was applied. The electrode was stable during the experiments and its open circuit potential changed less than 1 mV. Separately, samples were prepared for scanning electron microscopy (SEM) and EDAX analysis that were obtained by using a Hitachi S-2500 Delta SEM.

Table 3 presents corrosion resistance data for electroless plated prepared at different bath temperatures. In general, increasing the temperature from 25° C to 75° C leads to an increase in resistance. However, increasing the temperature further to 85° C

- 5 results in decrease in resistance. For these samples, 75° C is a desirable bath temperature for electroless mineralization.

Table 3. Comparison of corrosion resistance for samples mineralized at different bath temperatures. Resistance ($\Omega\text{-cm}^2$) in pH 4, 0.5 M Na_2SO_4						
Temperature	25° C		75° C		85° C	
Location	Immediate Rinse	24 Hour Rinse	Immediate Rinse	24 Hour Rinse	Immediate Rinse	24 Hour Rinse
1	301	216	586	1136	249	718
2	225	321	697	846	519	835
3	265	345	948	1223	1078	638
4	400	425	840	921	1429	648
5	350	500	858	1458	819	720
6	215	322	996	3465	534	810
Avg.	292.7	354.8	821	1508	771.3	728.2
High	400	500	996	3465	1429	835
Low	215	216	586	846	519	638

- Table 4 presents corrosion resistance data for electroless plated samples prepared at pH 10.5 and 11. Increasing the pH from 10.5 to 11 leads to an increase in average resistance. Samples that are rinsed after 24 hours typically exhibit better corrosion resistance than samples rinsed immediately. The same trend is observed for the samples prepared at different temperatures. Fig. 8 shows a comparison of the SEM and EDAX analysis of samples rinsed immediately and rinsed after 24 hours. Samples rinsed immediately have no detectable Si on the surface whereas samples rinsed after 24 hours show 12 % Si on the surface. This corresponds to the increased resistance shown in Tables 3 and 4.

Table 4. Comparison of corrosion resistance for samples mineralized at different pH in 1:8 sodium silicate at 75° C. Resistance ($\Omega\text{-cm}^2$) in pH 4, 0.5 M Na_2SO_4

pH	10.5		11	
Location	Immediate Rinse	24 Hour Rinse	Immediate Rinse	24 Hour Rinse
1	586	1136	712	1000
2	697	846	896	1295
3	948	1223	686	1327
4	840	921	609	983
5	858	1458	799	4092
6	996	3465	826	2509
Avg.	821	1508	755	1868
High	996	3465	896	4092
Low	586	846	609	983

5

Table 5 presents compares the corrosion resistance of samples with different deposition times. In general, the resistance ranges from 1400-1700 W-cm².

Table 5. Corrosion resistance for samples mineralized in 1:8 sodium silicate at 75 ° C at different deposition times. Resistance (Ω -cm ²) in pH 4, 0.5 M Na ₂ SO ₄				
Location	5 minutes	10 minutes	15 minutes	20 minutes
1	2500	1885	2412	759
2	754	684	867	2295
3	913	2286	1686	1959
Avg.	1389	1618.3	1655	1668
High	2500	2286	2412	2295
Low	754	684	867	759

10

In view of the above data presented in Example 1 and 2, one of skilled in the art should understand and appreciate that the mineralization bath should be heated, typically to a temperature of about 70 to 80 C. One should also note that in general, rinsing the samples 24 hours after mineralization results in increased resistance measurements and higher silicon content than samples immediately rinsed after treatment. Finally it should

- 5 be noted by a skilled artisan, that the corrosion resistance of the sample verse time is optimized after approximately 15 minutes of treatment in the mineralization bath. The temperature of the bath, silicate concentration and drying regime can be employed for optimizing the corrosion resistance of the treated metal surface.

10

EXAMPLE 3

As shown above, samples that are rinsed after 24 hours can show increased resistance compared to samples that are rinsed immediately, suggesting that the silicate dries and crystallizes on the surface. The present example demonstrates (i) the effect of post-mineralization heating and (ii) the effect of the concentration of the silicate bath.

15

A first set of samples were mineralized in a 1:8 (alkali:silica ratio) silicate solution for 15 minutes and dried at 100° C for one hour immediately. A second set was mineralized and left to dry at room temperature for 24 hours. Table 6 shows corrosion resistance for the samples. Heating results in a dramatic increase in corrosion resistance, but the resistance may not be uniform across the samples, indicating non-uniformity of Si

20

Table 6. Comparison of resistance for samples mineralized in 1:8 sodium silicate with and without post-deposition heating. Resistance ($\Omega\text{-cm}^2$) in pH 4, 0.5 M Na_2SO_4		
Location	No Heating	Heating at 100° C for 1 hour
1	2412	4.4×10^4
2	867	4.7×10^4
3	1686	725.2
Avg.	1655	3.1×10^4
High	2412	4.7×10^4
Low	867	725.2

- Table 7 shows the corrosion resistance of samples mineralized as above and heated at different temperatures for one hour. Increasing the drying temperature typically
- 25 increases the average resistance.

Table 7. Comparison of resistance for samples mineralized in 1:8 sodium silicate and heated at different post-deposition temperatures. Resistance ($\Omega\text{-cm}^2$) in pH 4, 0.5 M Na_2SO_4 .

Location	100° C	125° C	150° C	175° C	200° C
1	4.4×10^4	702.9	8.2×10^4	1.2×10^5	2.1×10^5
2	4.7×10^4	6.8×10^4	8.4×10^4	1600	780.7
3	725.2	4.0×10^4	1644.3	8.2×10^4	2.3×10^4
Avg.	3.1×10^4	3.5×10^4	5.6×10^4	6.8×10^4	7.8×10^4
High	4.7×10^4	6.8×10^4	8.4×10^4	1.2×10^5	2.1×10^5
Low	725.2	702.9	1644.3	1600	780.7

5

The samples of Table 8 were placed under water for seven days, and the corrosion resistance determined periodically. As shown in Table 8, the resistance drops to less than 1000 $\Omega\text{-cm}^2$ for all the samples after seven days. Without wishing to be bound by any theory of explanation it is believed that water can penetrate through microcracks in the coating and attacks the underlying layer. The dissolution of Zn can lead to the removal of the protective coating and eventually causes the corrosion rate to increase.

10

Table 8. Comparison of resistance after 1 week immersed in water for surfaces mineralized in 1:8 sodium silicate. Resistance ($\Omega\text{-cm}^2$) in pH 4, 0.5 M Na_2SO_4 .

No. of days	100° C	125° C	150° C	175° C	200° C
Initial	3.1×10^4	3.6×10^4	6.0×10^4	6.5×10^4	8.1×10^4
1 day	822.8	844.1	1240.5	1521.6	1623.5
4 days	580.1	612.5	800.2	911.3	954
7 days	400.1	512.3	564.7	603.1	625.4

Table 9 presents corrosion resistance data for samples mineralized in different concentrations of silicate solution. In this example, a series of bath solutions having differing ratios of PQ solution to water were prepared. For example, a 1:1 solution was prepared by adding 1 part PQ solution to 1 part water. Following mineralization, the

15

- 5 samples were heated at 100° C for 1 hour. Data representative of the results achieved are given below. One of skill in the art should understand and appreciate that the corrosion resistance generally increases with bath concentration. With the 1:8 and the 1:4 baths, the corrosion resistance appears to be variable across the surface. However, with the 1:3 ratio bath and higher ratio baths, resistances in the range of $10^5 \Omega\text{-cm}^2$ are measured
- 10 across the surface. Thus one of skill in the art should conclude that the 1:3 is a desirable bath concentration for these samples.

Table 9. Comparison of resistance for surfaces mineralized in different concentrations of sodium silicate solution. Resistance ($\Omega\text{-cm}^2$) in pH 4, 0.5 M Na_2SO_4

Location	1:8	1:4	1:3	1:2	1:1
1	4.4×10^4	8200	3.3×10^5	7.7×10^5	2.2×10^6
2	4.7×10^4	1.7×10^5	1.8×10^5	1.2×10^6	1.8×10^6
3	725.2	3.0×10^5	4.9×10^5	1.3×10^6	1.9×10^6
Avg.	3.1×10^4	6.9×10^4	3.3×10^5	1.1×10^6	2.0×10^6
High	4.7×10^4	3.0×10^5	4.9×10^5	1.3×10^6	2.2×10^6
Low	725.2	8200	1.8×10^5	7.7×10^5	1.8×10^6

- Samples mineralized in 1:3 sodium silicate were heated at different temperatures
- 15 for 1 hour and kept under water for seven days. As shown in Table 10, the resistances measured immediately after drying, indicate that increasing drying temperature tends to increase the average resistance of the samples. However, the resistances of all the samples can drop to under 1000 $\Omega\text{-cm}^2$ after seven days immersed in water.

Table 10. Comparison of resistance after 1 week immersed in water for surfaces mineralized in 1:3 sodium silicate and heated at various temperatures for 1 hour. Resistance ($\Omega\text{-cm}^2$) in pH 4, 0.5 M Na_2SO_4 .

Location	Room temp.	100° C	125° C	150° C	175° C	200° C
1	2246	3.3×10^5	7.1×10^5	7.2×10^5	3.2×10^5	8.0×10^5
2	1879	1.8×10^5	6.8×10^5	8.4×10^5	1.2×10^6	1.5×10^6

3	2224	4.9×10^5	1.4×10^5	4.8×10^5	9.2×10^5	1.0×10^6
Avg.	2116.2	3.3×10^5	5.1×10^5	6.8×10^5	8.1×10^5	1.1×10^6
High	2246	4.9×10^5	7.8×10^5	8.4×10^5	1.2×10^6	1.5×10^6
Low	1879	1.8×10^5	1.4×10^5	4.8×10^5	3.2×10^5	8.0×10^5

5

Table 11. Comparison of resistance after immersion in water for surfaces mineralized in 1:3 sodium silicate and heated at various temperatures for 1 hour. Resistance ($\Omega\text{-cm}^2$) in pH 4, 0.5 M Na_2SO_4 .

Days	Room temp.	100° C	125° C	150° C	175° C	200° C
Initial	2116.2	3.5×10^5	5.0×10^5	6.8×10^5	8.4×10^5	1.3×10^6
1	632.1	2247.8	2509	2496.2	3561.3	3626
4	601.1	1028.2	978	856.3	1211.3	1490.4
7	580	532.1	612.3	632.6	657.7	691.9

The dried samples can be rinsed to remove any water soluble species. If desired, the rinse solution can comprise at least one composition for further modifying the dried sample (e.g., silanes, colloidal silica, among other materials).

10

EXAMPLE 4

Hydrogen is evolved at the surface of the cathode during electroplating and the rate of hydrogen evolution can be controlled by varying the applied potential or current. Hydrogen production also releases hydroxyl groups into the solution thereby increasing pH. However, in the case of electroless deposition, this can be accomplished through the use of selected reducing agents.

Fig. 9 presents the Si concentration of samples mineralized in 1500 mL of 1:3 sodium silicate in the presence of increasing amounts of sodium borohydride. Comparison of the samples dried in air with the samples heated at 175° C is shown. With samples dried in air, the Si content increases with borohydride concentration. With the heated samples, the Si content initially decreases with borohydride concentration, but no decrease is observed at borohydride concentrations greater than 5 g.

20

5 The stability of the coatings prepared without post-deposition heating is shown in Table 12 (note as shown above post-deposition heating improves corrosion resistance). The stability of the coatings is improved by the addition of sodium borohydride. The corrosion resistance of the coatings prepared with 10 g of sodium borohydride drops from 1941.5 W-cm² to 1372.1 W-cm² after seven days, whereas the resistance of coating
 10 prepared in the absence of sodium borohydride drops from 2116.2 W-cm² to 580 W-cm². Fig. 10 shows a plot of this data.

Table 12. Comparison of resistance after immersion in water for surfaces mineralized in 1500 mL of 1:3 sodium silicate in the presence of various amounts of sodium borohydride. Resistance (Ω -cm²) in pH 4, 0.5 M Na₂SO₄.

Days immersion	No NaBH ₄	5 g NaBH ₄	10 g NaBH ₄	15 g NaBH ₄
Initial	2116.2	1870.1	1941.5	2168.9
1	632.1	1650.7	1660.2	2071.7
4	601.1	1072.1	1491.8	1856.2
7	580	830.1	1372.1	1590.1

A similar trend is observed with samples subjected to post-mineralization heating at 175° C for one hour. The average resistance of the coating prepared using 10 g of
 15 sodium borohydride drops to 1488.6 W-cm² after seven days, compared to 570.7 W-cm² observed after seven days for the coating prepared in the absence of sodium borohydride (Table 13). A plot of this data is shown in Fig. 11.

Table 13. Comparison of resistance after immersion in water for surfaces mineralized in 1500 mL of 1:3 sodium silicate in the presence of various amounts of sodium borohydride and heated at 175° C for one hour. Resistance (Ω -cm²) in pH 4, 0.5 M Na₂SO₄

Days immersion	No NaBH ₄	5 g NaBH ₄	10 g NaBH ₄	15 g NaBH ₄
Initial	3.3x10 ⁵	4.1x10 ⁴	1.9x10 ⁴	3456
1	1690.4	1488.6	2677.8	2131.2
4	983.1	1132.4	1939.0	1446.7
7	570.7	916.1	1488.6	1243.1

5 Surfaces mineralized in 1500 mL of 1:3 sodium silicate in the presence of different amounts of sodium borohydride were used as working electrodes for cyclic voltammetry in a three electrode cell, using a calomel reference electrode and a scan rate of 5 mV/s. One set of surfaces was dried in air for 24 hours, while a second set was heated at 175° C for one hour. Fig. 12 shows voltammograms for the air dried samples.
10 The observed current corresponds to corrosion of the surface layer. At a bare galvanized surface, increasing the potential more positive than -1.1 V leads to stripping Zn from the surface. In the reverse scan, deposition is observed as mass transfer limited current.

For the SiO₂-coated surfaces, peak reduction current and maximum oxidation current can decrease rapidly. Since the currents are dependent of the amount of material
15 lost from the surface, the inhibiting efficiency of the silica on Zn can be estimated from the voltammograms as:

$$\text{Inhibiting efficiency (\%)} = [(\text{Peak Current Coated})/(\text{Peak Current Bare})] \times 100$$

Fig. 13 shows a plot of the inhibiting efficiencies from the voltammogram of Fig. 12. The inhibiting efficiency typically increases with increasing sodium borohydride
20 concentration.

Voltammograms of the surfaces coated in the presence of sodium borohydride and heated at 175° C for one hour are shown in Fig. 14. Currents in the SiO₂-coated samples are negligible compared to the bare surface. The inhibiting efficiency is shown in Fig. 15.

25 Cyclic voltammetry (CV) was performed with surfaces with and without post-mineralization heating after immersing them in water for one week. Fig. 16 shows the CVs of the samples prepared in the presence of different amounts of sodium borohydride and air-dried for 24 hours. The current increases to the order of 1 mA after one week. Fig. 17 shows the decrease in the inhibiting efficiency after one week immersion in
30 water. Similar results are observed for the surfaces subjected to post-deposition heating at 175° C for one hour (Figs. 18 and 19). The change in inhibiting efficiency is the lowest for samples prepared with 10 g of sodium borohydride.

Fig. 20 shows SEM images of surfaces prepared in the presence of 10 g of sodium borohydride before and after immersion in water. Upon inspection one of skill in the art
35 should notice that a 2 μm crack is observed. It will be appreciated by such a skilled

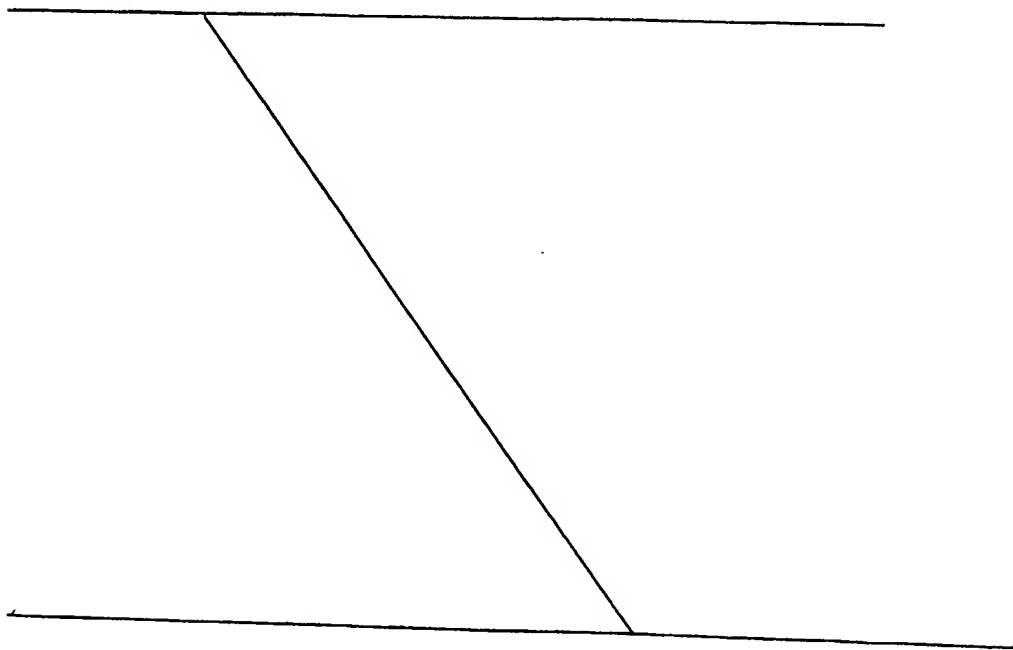
5 artisan that such cracks facilitate the entry of water through the coating and allow attack of the underlying surface. As the cracks become large, to the order of 8-10 mm and flakes of zinc appear on the surface. EDAX on surfaces coated in the presence of different amounts of sodium borohydride and left to dry in air for 24 hours indicates that the Si content drops for all the samples, but the drop is the least for the sample prepared
10 in the presence of 10 g of sodium borohydride (Fig. 21). Similar behavior is observed for surfaces prepared with post-deposition heating (Fig. 22).

These studies indicate to one of skill in the art that surfaces coated via electroless mineralization in the presence of sodium borohydride.

15

EXAMPLE 5

The following table shows examples of the inventive process that employs a heated silicate medium for treating standard M-10 bolts. The heated silicate medium comprised 10 % N-Grade PQ sodium silicate solution (which comprises 2.88% SiO₂, 0.90% alkali) and silica colloids that ranged in size from about 10 nm to about 1,000
20 nanometers (and typically 1 to 100nm).



STANDARD M-10 BOLT RUN PARAMETER SUMMARIES

Run #	Time (Min)	Bath Temp (C)	CD (ASI)	A:C Area	Number Of Bolts	Total Bolt Area (sq. in)	D.C. Current (A)	D.C. Potential (V)	Results
1	15	74.3-75.8	0.055	1-1.9	100	500	28	10.7-15.0	Bright & Silvery Appearance
2	0	N/A	0	0	100	500	0	0	Eclipse Zinc Plate Control
3	0	N/A	0	0	100	500	0	0	Eclipse Zinc Plate Control
4	15	74.6-75.5	0.055	1-1.9	100	500	27.5	10.9-12.3	Bright & Silvery Appearance
5	15	71.3-74.5	0	0	100	500	0	0	Hot Soak
6	15	72.8-75.1	0	0	100	500	0	0	Hot Soak
7	0	N/A	0	0	100	500	0	0	Eclipse Zinc Supplied by Atotech®
8	0	N/A	0	0	100	500	0	0	Eclipse Zinc Supplied by Atotech®
9	15	36.3-37.1	0	0	68	340	0	0	Cold Soak
10	15	74.5-75.6	0	0	22	110	0	0	Hot Soak
1	0	N/A	0	0	6	30	0	0	Zinc Plate Control
2	15	26.6	0	0	23	115	0	0	Cold Soak
3	15	74.3-75.6	0	0	24	120	0	0	Hot Soak
4	2.5	73.1-74.9	0.1	1-1	53	265	27	<24.7	Bright & Silvery Appearance
5	15	24.6	0	0	9	45	0	0	Cold Soak/New Solution
6	15	73-75	0	0	9	45	0	0	Hot Soak/New Solution
7	15	74.5-75.2	0	0	6	30	0	0	Hot Soak

**POST-
TREATMENT/TOPCOATS**

Group #	Run#	Post-Treat.	Top-Coat
1A	2	Dry Only	None
1B	3	Dry Only	None
2	3	Dry Only	Magni® B17
3	2	Dry Only	Magni® B18
4A	5	A Process	None
4B	6	A Process	None
5	6	A Process	Magni® B17
6	5	A Process	Magni® B18
7A	1	A Process	None
7B	4	A Process	None
8	4	A Process	Magni® B17
9	1	A Process	Magni® B18
10	7/8	Corrosil	None
11	7/8	Corrosil	Magni® B17
12	7/8	Corrosil	Magni® B18
13	7/8	Ecotri	None
14	7/8	Ecotri	Magni® B17
15	7/8	Ecotri	Magni® B18
16	9	Dry Only	None

A Process
 1. 90 Sec. Spin
 Dry
 2. 10 sec. De-ionized Water
 Rinse
 3. 60 Sec. Spin
 Dry
 4. 10 Sec. A1 Silane Rinse
 5. 60 Sec. Spin
 Dry
 6. 10 Sec. A2 Silane Rinse
 7. 90 Sec. Spin
 Dry
 Corrosil & Ecotri Treatments
 Applied By
 Atotech
 Topcoats -0.2 mil thickness

17	9	A Process	None
18	9	A Process	Magni® B17
19	9	A Process	Magni B®18
20	10	A Process	None
1	1	Dry Only	None
2	2	Dry, Rinse, Dry	None
3	3	Dry, Rinse, Dry	None
4	4	Dry, Rinse, Dry	None
5	5	Immediate Rinse	None
6	5	Dry, Rinse, Dry	None
7	6	Immediate Rinse	None
8	6	Dry, Rinse, Dry	None
9	7	Spin Dry Only	None
10	6	Spin Dry Only	None

New Solution:
New Solution:
New Solution:
New Solution:
Ripened
Solution
New Solution:

- Notes: 1. Temperature on all runs maintained 74-77 C
 2. All runs performed in a Sterling Model 612 plating barrel at 11-12 rpm
 3. All runs performed with a 265 square inch platinum coated niobium mesh anode positioned in a semi-circular position around the plating barrel, 1.5 inches from the exterior of the barrel
 4. RA=only a spin dry(90 Seconds) after electrolytic treatment and salt spray testing delayed ~24 Hours
 5. RB=90 sec spin dry, 10 sec. Deionized water rinse, 90 sec spin dry and salt spray testing delayed ~24 Hours
 6. RC=90 sec spin dry, 10 sec. Deionized water rinse, 90 sec spin dry and salt spray testing within 2 Hours
 7. A1 Silane: 88.137% water, 0.063% 7-Diethylamino-4-methylcoumarin [UV dye], 9.8% Denatured alcohol, 2% Bis(Triethoxysilyl) Ethane [silane]
 8. A2 Silane: same as A1 except silane component comprises 2-(3,4-Epoxy cyclohexyl)-Ethyltrimethoxysilane
 9. New Solution = Solution without exposure to current and having colloids in size ranging from about 10 to 100nm.
 10. Ripened Solution = Solution with significant exposure to current and having colloids in size ranging from about 10 to 1,000 micrometers.

5 Upon review of the above representative data and information, one of skill in the art should understand and appreciate that the process of the present invention can be carried out in a routine manner on industrial parts and workpieces using standard metal finishing equipment. It should also be appreciated that the mineralized samples can be further treated with a top coat or other additional protective coating to aid in the handling
10 and transport of the mineralized parts or workpieces.

EXAMPLE 6

The present example illustrates the effect of post-treatment heating of the samples. The edge of a 2.75 inch diameter X 6 inch long electric motor laminate core assembly comprising individual laminates (high silicon steel alloy) mechanically coined together and assembled onto a simulated shaft was treated. These laminates can be used from constructing the rotor of an electric motor. Mineralization was carried out in a 1:3 ratio bath made of 1 part sodium silicate (PQ) solution and 3 parts water. The temperature of the bath was maintained at 75 C and a deposition time of 15 minutes. Post
15 treatment heating of the samples was carried out at 25 C until the sample was dry and 175 C until the sample was dry.

Data representative of the corrosion resistance ($\Omega\text{-cm}^2$) in pH 4, 0.5 M Na_2SO_4 Solution of the samples mineralized in a 1:3 PQ Bath at pH 10.5 for 15 minutes is given below

Location	25 C dry	120 C dry
1	1087.8	38146
2	2222.1	61923
3	1600	48083
Average Value	1636.6	49384

25

Data representative of the corrosion resistance ($\Omega\text{-cm}^2$) in pH 4, 0.5 M Na_2SO_4 Solution of the samples mineralized in Mineralize in 1:3 PQ Bath with NaBH_4 (10 g/l), at pH 10.5 for 15 minutes is given below

Location	25 C dry	120 C dry
----------	----------	-----------

1	6883.2	26961
2	15108	27049
3	7711.4	24858
Average Value	9900.9	26289

5

EDAX analysis of the samples dried at 25 C and prepared in the NaBH₄ containing bath is compared to the samples prepared without the NaBH₄ gave the following exemplary data:

	NaBH ₄ Bath	Control (no NaBH ₄)
Atomic %		
Oxygen	0.000	0.000
Silicon	55.187	42.329
Iron	44.813	57.671
Conc. (Wt %)		
Oxygen	0.00	0.000
Silicon	38.247	26.960
Iron	61.753	73.040

10

Upon review of the above exemplary data, one of skill in the art should understand and appreciate that the inclusion of NaBH₄ into the mineralization bath substantially increases the mineralized protective layer formed.

Examples 7-9 illustrate silicate media containing complexing agents and dopants.

15 These silicate media were prepared in laboratory scale equipment.

EXAMPLE 7

20 20 gms of sodium citrate dihydrate (complexing agent), 1gm Nickel chloride (dopant), 1 gm Molybdenum (dopant), and 1 gm cobalt chloride (dopant) were dissolved in 500 ml of water to prepare a first solution. Then and 0.5 gm of MgO and 1 gm aluminum dissolved in 1:3 sodium silicate solution (supplied by PQ) which when added

- 5 to the 500 ml water makes up 1:3 bath to prepare a second solution. The first and second solutions were combined. The combined solution had a violet hue and pH of about 11.5.

EXAMPLE 8

- 20 gms of sodium citrate dihydrate, 1gm nickel chloride, 1 gm cobalt chloride,
10 and 0.5 gm molybdenum were dissolved in 500 ml of water in order to prepare a first solution. Then a second solution of 1:3 sodium silicate was prepared. The first and second solutions were combined. The combined solutions had a violet hue and pH of about 11.0.

EXAMPLE 9

- 15 20 gms of Sodium citrate dihydrate, 1gm Nickel chloride, 0.5 gm Molybdenum, and 1 gm cobalt chloride were dissolved in 500 ml of water in order to prepare a first solution. A second solution comprising 1:3 sodium silicate was prepared. The first and second solutions were combined.

- If desired a reducing agent solution comprising sodium borohydride (e.g., 4 grams
20 of sodium borohydride dissolved in 50 ml water) can be added to solutions of Examples 7-9.

- While the apparatus, compositions and methods of this invention have been described in terms of preferred or illustrative embodiments, it will be apparent to those of skill in the art that variations may be applied to the process described herein without
25 departing from the concept and scope of the invention. All such similar substitutes and modifications apparent to those skilled in the art are deemed to be within the scope and concept of the invention.

30

35

5 THE FOLLOWING IS CLAIMED:

1. An electroless method for treating a substrate having an electrically conductive surface comprising:

contacting at least a portion of the surface with a medium comprising at least one
10 silicate and having a basic pH and wherein said medium is substantially free of chromates,

drying the substrate,

rinsing the substrate,

drying the substrate.

15

2. An aqueous medium for use in an electroless process for treating a conductive surface comprising a combination comprising water, at least one water soluble silicate, colloidal silica, at least one dopant and wherein the medium has a basic pH and is substantially free of chromates and VOCs.

20

3. An electroless method for treating a metallic or an electrically conductive surface comprising:

exposing at least a portion of the surface to a medium comprising a combination comprising water, colloidal silica, and at least one water soluble silicate wherein said
25 medium has a basic pH,

drying the surface,

rinsing the surface,

drying the surface; and

contacting the treated surface with at least one composition that adheres to the
30 treated surface.

4. The method of Claim 1 wherein the medium comprises water, sodium silicate and colloidal silica.

- 5 5. The method of Claim 1 wherein the surface comprises at least one member
selected from the group consisting of copper, nickel, tin, iron, zinc, aluminum,
magnesium, stainless steel and steel and alloys thereof.
- 10 6. The method of Claim 1 wherein said rinsing comprises contacting the surface
with a second medium comprising a combination comprising water and at least one water
soluble compound selected from the group consisting of carbonates, chlorides, fluorides,
nitrates, zirconates, titanates, sulphates, water soluble lithium compounds and silanes.
- 15 7. The method of Claim 1 wherein the medium comprises at least one dopant
selected from the group consisting of zinc, cobalt, molybdenum and nickel.
8. The method of Claim 1 wherein said first drying is conducted at a temperature
of at least about 120C.
- 20 9. The method of Claim 1 further comprising applying at least one coating upon
the surface.
10. The medium of Claim 2 wherein the medium comprises a combination
comprising water, colloidal silica, greater than 1 wt.% of sodium silicate and further
25 comprises at least one dopant selected from the group consisting of cobalt, nickel,
molybdenum and zinc.
11. The method of Claim 1 further comprising forming a layer comprising silica
upon the surface.
- 30 12. The medium of Claim 3 wherein said dopant comprises at least one member
selected from the group consisting of from the group of titanium chloride, tin chloride,
zirconium acetate, zirconium oxychloride, calcium fluoride, tin fluoride, titanium
fluoride, zirconium fluoride; ammonium fluorosilicate, aluminum nitrate; magnesium

5 sulphate, sodium sulphate, zinc sulphate, copper sulphate; lithium acetate, lithium bicarbonate, lithium citrate, lithium metaborate, lithium vanadate and lithium tungstate.

13. The method of Claim 1 wherein said medium comprises sodium silicate, water, colloidal silica and at least one dopant, said rinsing is conducted with a second
10 medium comprising water and at least one member selected from the group consisting of silanes and colloidal silica and further comprising applying at least one secondary coating comprising at least one member selected from the group consisting of acrylics, urethanes, polyester and epoxies.

15 14. The method of Claim 1 wherein said rinsing comprising contacting said surface with a solution comprising water and at least one dopant.

15. The method of Claim 14 wherein the dopant comprises at least one member selected from the group consisting of molybdenum, chromium, titanium, zircon,
20 vanadium, phosphorus, aluminum, iron, boron, bismuth, gallium, tellurium, germanium, antimony, niobium, magnesium, manganese, zinc, aluminum, cobalt, nickel and their oxides and salts.

16. The method of Claim 3 further comprising prior to said exposing contacting
25 said surface with a pretreatment comprising at least one member selected from the group consisting of acid and basic cleaners.

17. The method of Claim 1 wherein said medium further comprises at least one
30 dopant.

18. The method of Claim 3 wherein said adherent composition comprises at least one member chosen from the group of latex, silanes, epoxies, silicone, amines, alkyds, urethanes, polyester and acrylics.

- 5 19. An article comprising an electrically conductive substrate comprising zinc
wherein at least a portion of which has an inorganic and chromate free surface and at
least one composition adhered to said article and wherein said has an ASTM B117
exposure to white rust of greater than 72 hours.

10

15

20

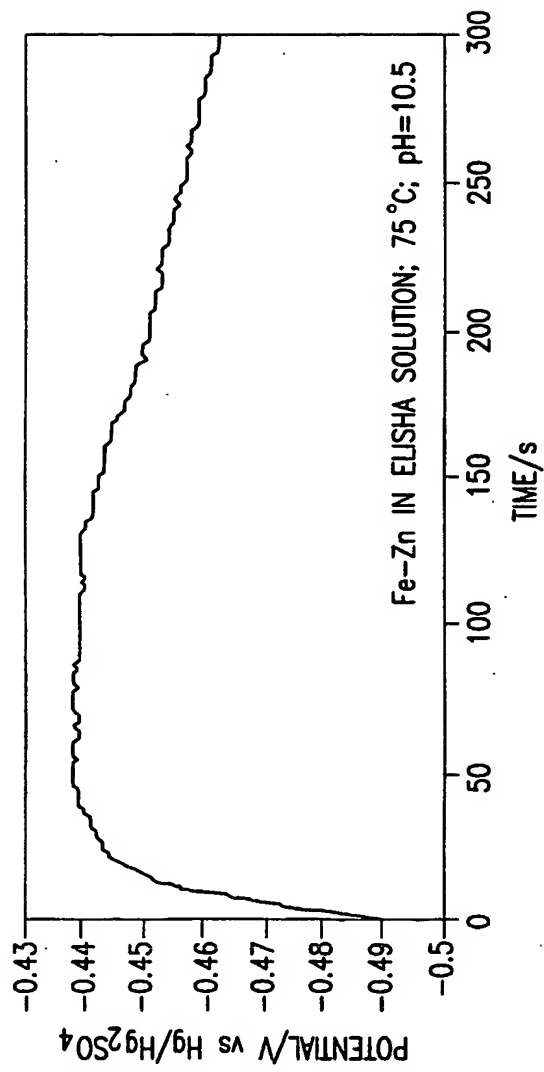
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OPEN CIRCUIT POTENTIAL

FIG.1

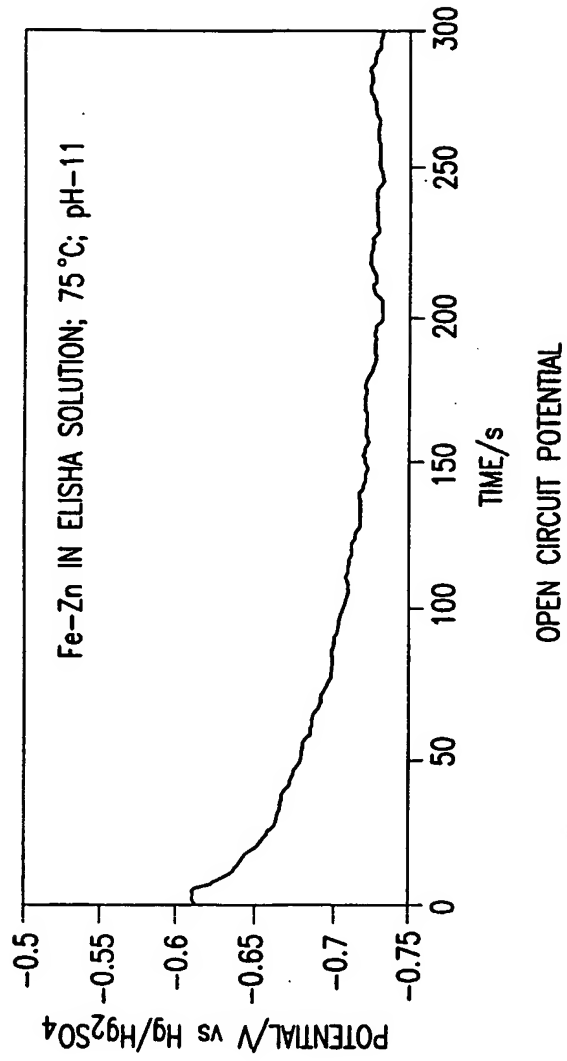


FIG.2

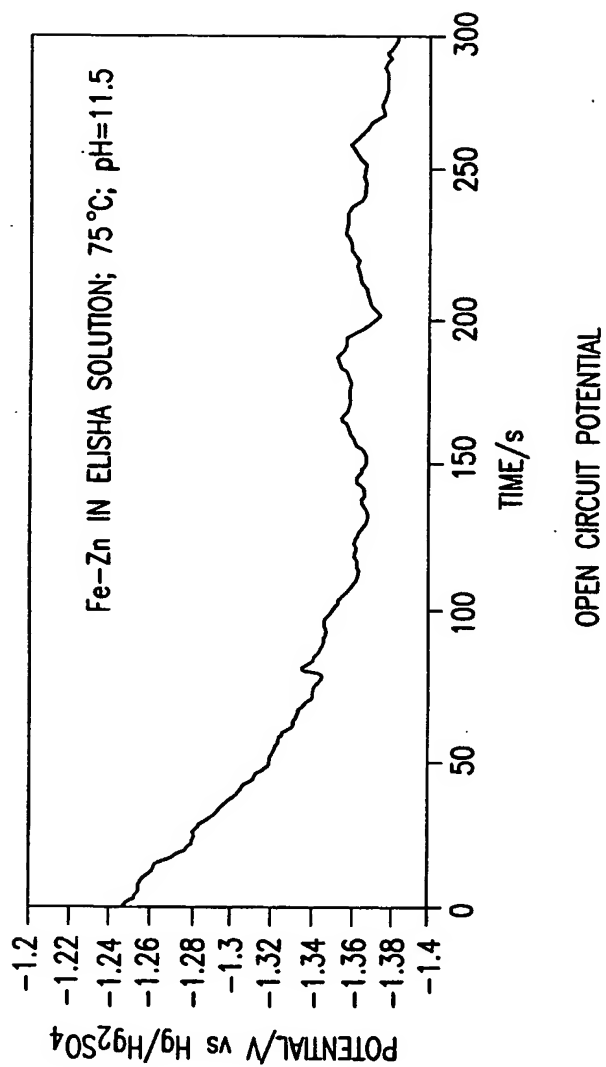


FIG.3

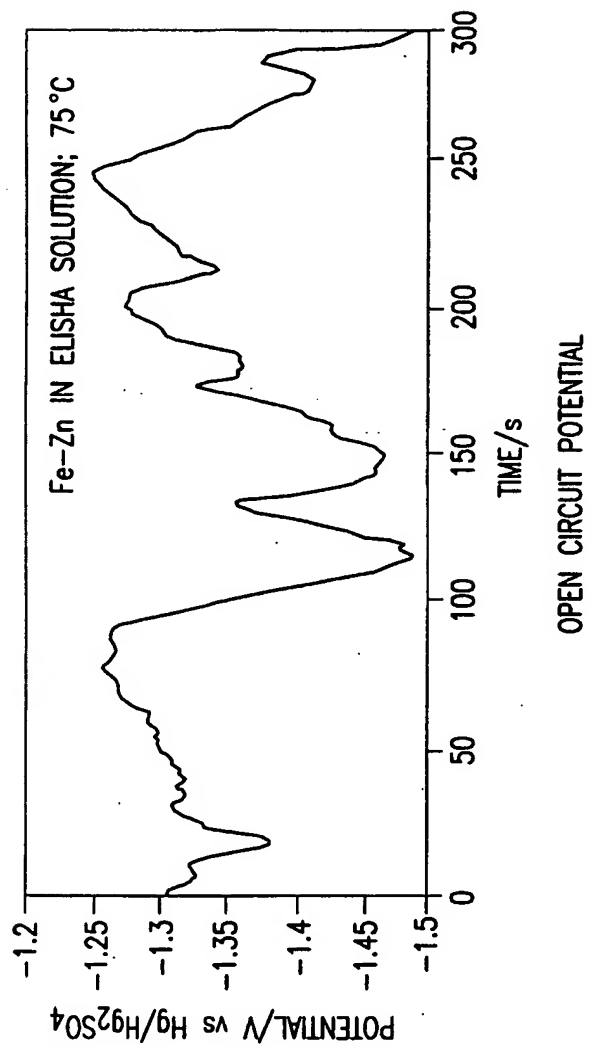


FIG.4

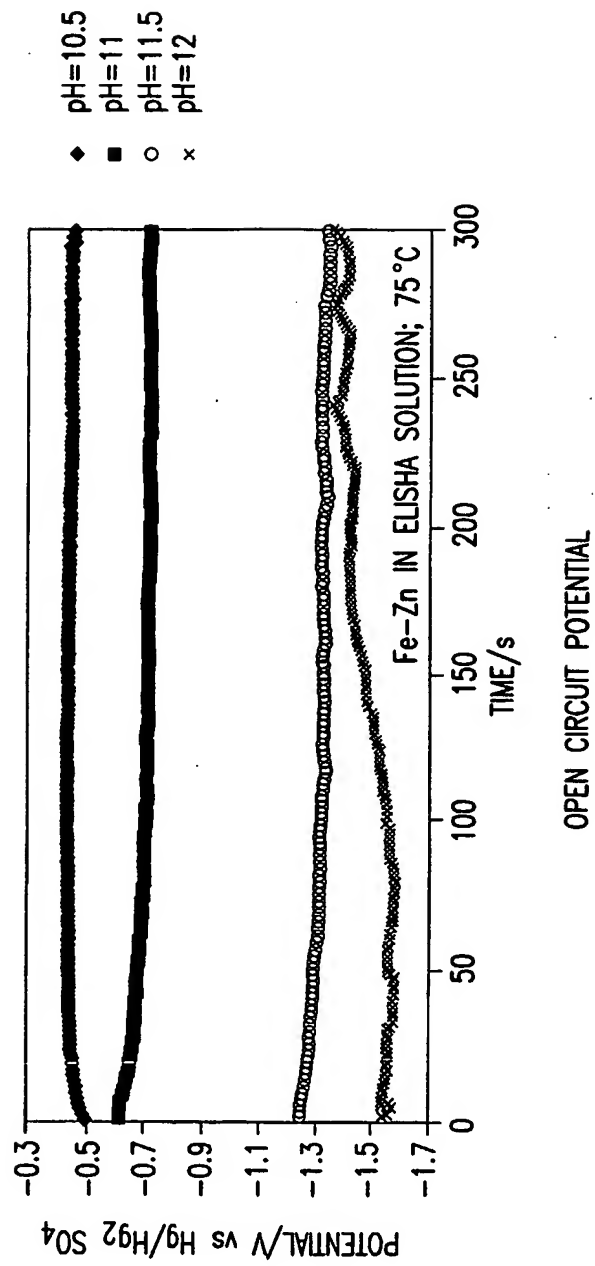


FIG.5

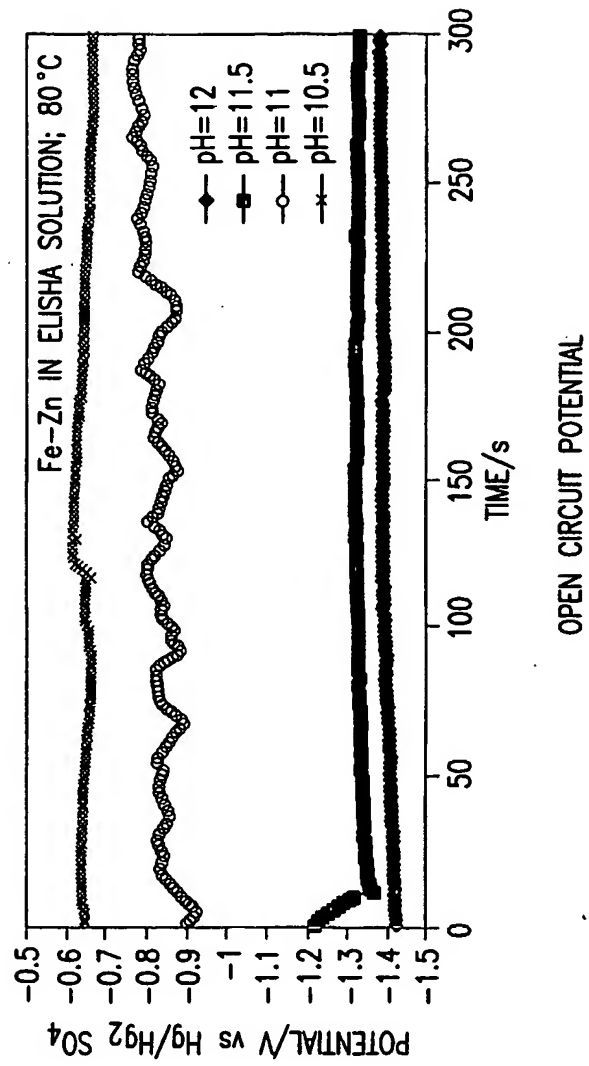


FIG.6

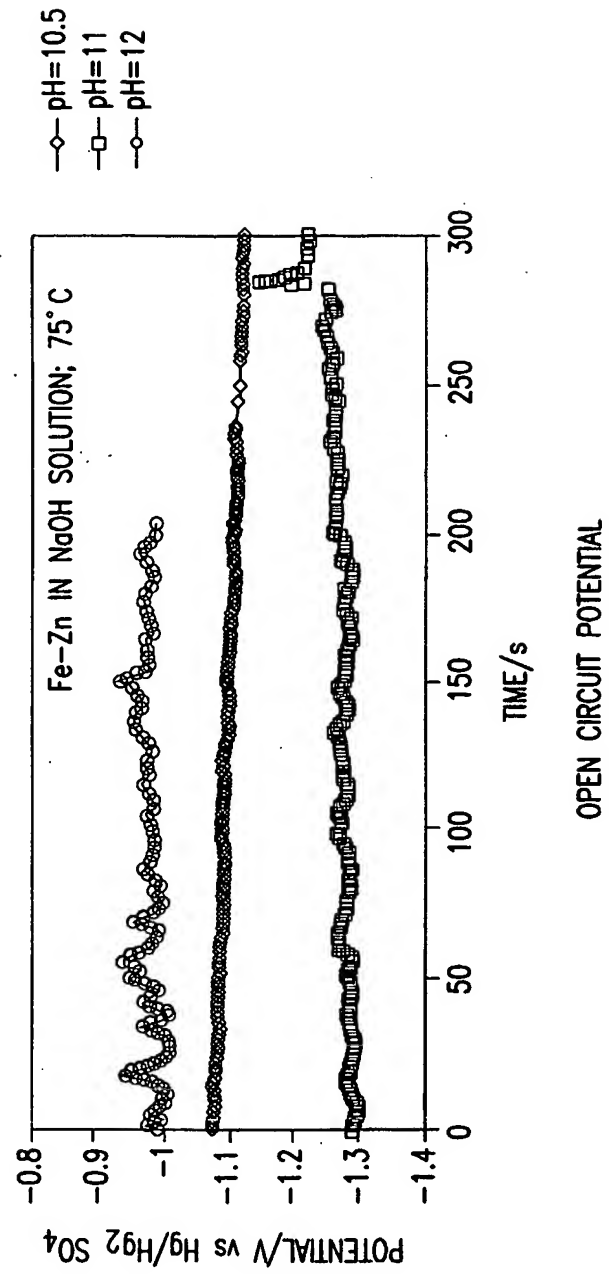
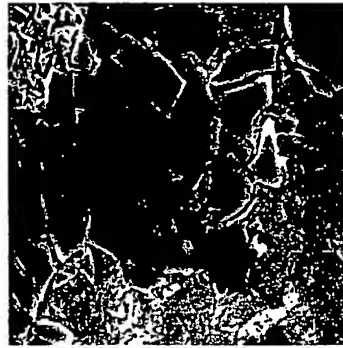


FIG.7

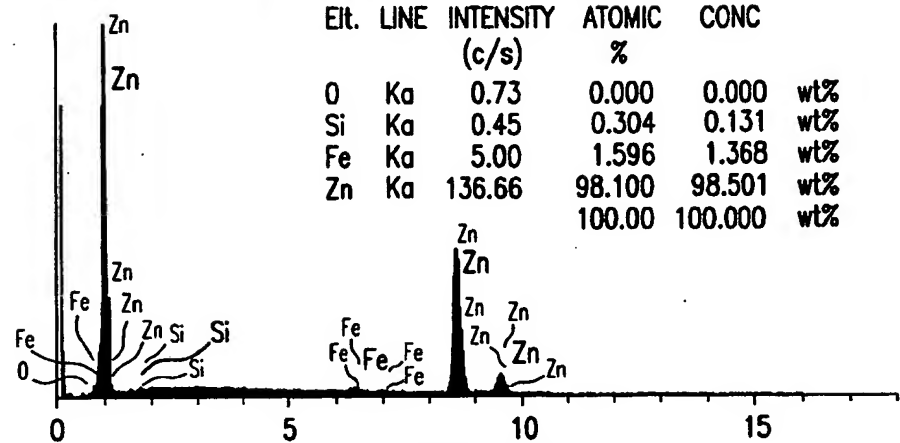
8/16

SEM & EDAX ANALYSIS OF SAMPLES RINSED IMMEDIATELY AND RINSED LATER
RINSED IMMEDIATELY

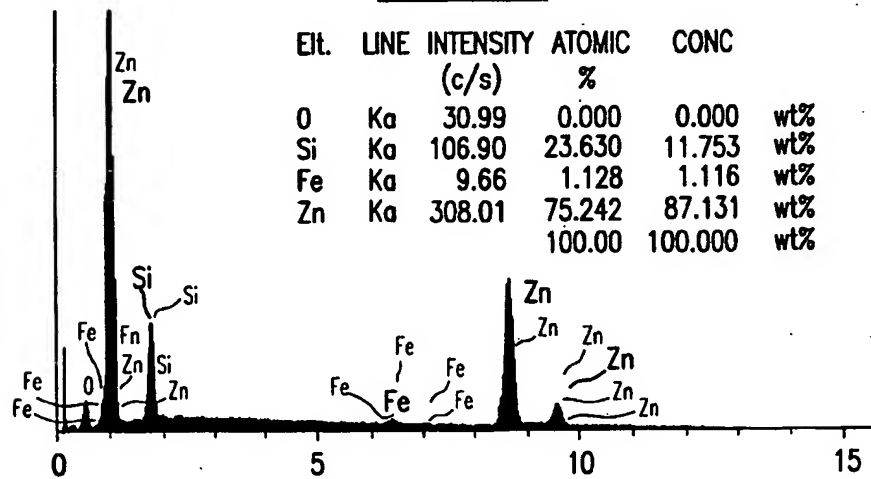
FIG.8



MAGNIFICATION-1000 X



RINSED LATER



SUBSTITUTE SHEET (P.11 F.26)

COMPARISON OF Si CONTENT FOR SAMPLES MINERALIZED IN 1:3
PQ SOLUTION WITH NO CURRENT AND WITH DIFFERENT AMOUNTS OF
SODIUM BOROHYDRIDE

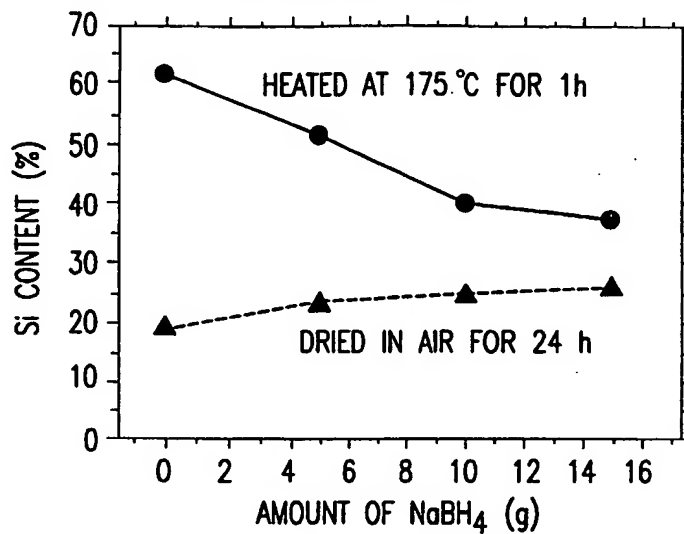


FIG.9

DROP IN CORROSION RESISTANCE FOR SAMPLES MINERALIZED
IN 1:3 PQ SOLUTION WITH NO CURRENT AND WITH DIFFERENT
AMOUNTS OF SODIUM BOROHYDRIDE
SAMPLES WERE DRIED IN AIR FOR 24 HOURS AND LEFT IN WATER FOR 1 WEEK

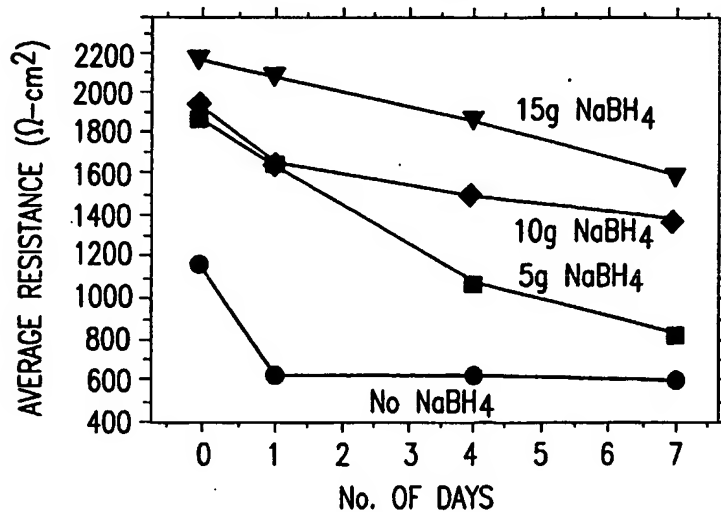


FIG.10

SUBSTITUTE SHEET (RULE 26)

DROP IN CORROSION RESISTANCE FOR SAMPLES MINERALIZED
IN 1:3 PQ SOLUTION WITH NO CURRENT AND WITH DIFFERENT
AMOUNTS OF SODIUM BOROHYDRIDE SAMPLES WERE DRIED AT 175°C
FOR 1 HOUR AND LEFT IN WATER FOR 1 WEEK

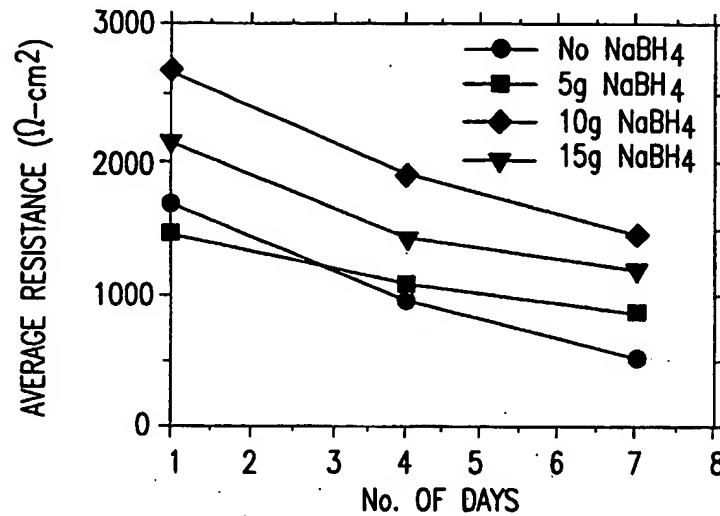


FIG.11

CVs FOR SAMPLES MINERALIZED IN 1:3 PQ SOLUTION WITH NO CURRENT AND
WITH DIFFERENT AMOUNTS OF SODIUM BOROHYDRIDE
SAMPLES WERE DRIED IN THE AIR FOR 24 HOURS

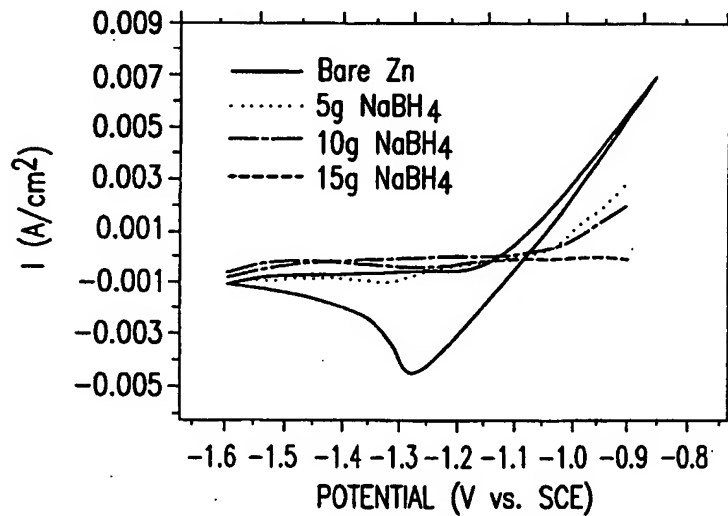


FIG.12

SUBSTITUTE SHEET (RULE 26)

INHIBITING EFFICIENCY OBTAINED FROM CVs FOR SAMPLES
MINERALIZED IN 1:3 PQ SOLUTION WITH NO CURRENT AND
WITH DIFFERENT AMOUNTS OF SODIUM BOROHYDRIDE
SAMPLES WERE DRIED IN AIR FOR 24 HOURS

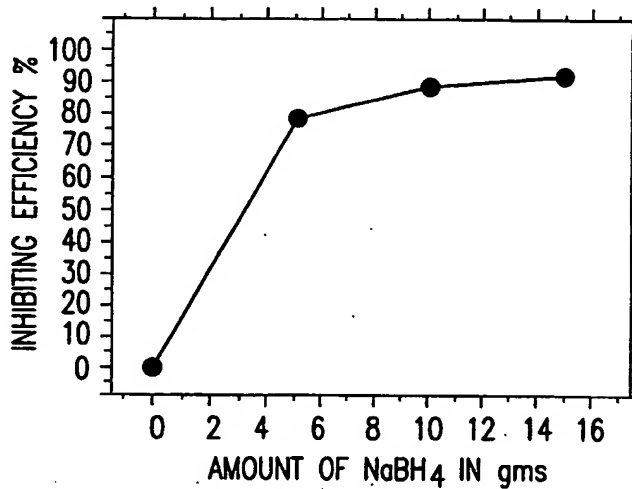


FIG.13

CVs FOR SAMPLES MINERALIZED IN 1:3 PQ SOLUTION WITH NO
CURRENT AND WITH DIFFERENT AMOUNTS OF SODIUM BOROHYDRIDE
SAMPLES WERE HEATED AT 175 °C FOR 1 HOUR

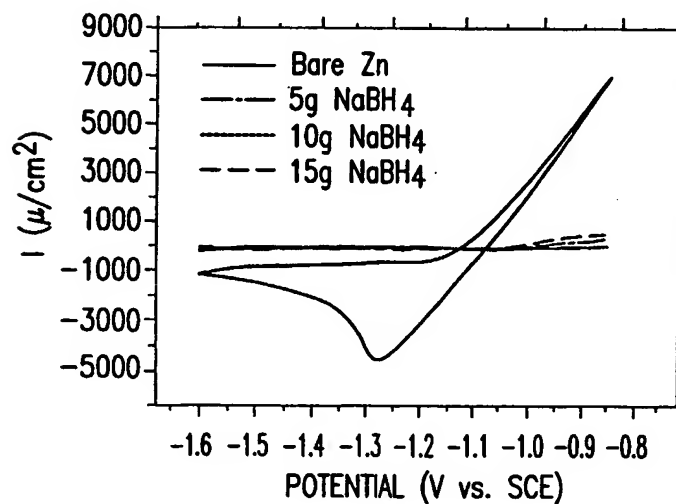


FIG.14

SUBSTITUTE SHEET (RULE 26)

INHIBITING EFFICIENCY OBTAINED FROM CVs FOR SAMPLES
MINERALIZED IN 1:3 PQ SOLUTION WITH NO CURRENT AND WITH
DIFFERENT AMOUNTS OF SODIUM BOROHYDRIDE
SAMPLES WERE HEATED AT 175°C FOR 1 HOUR

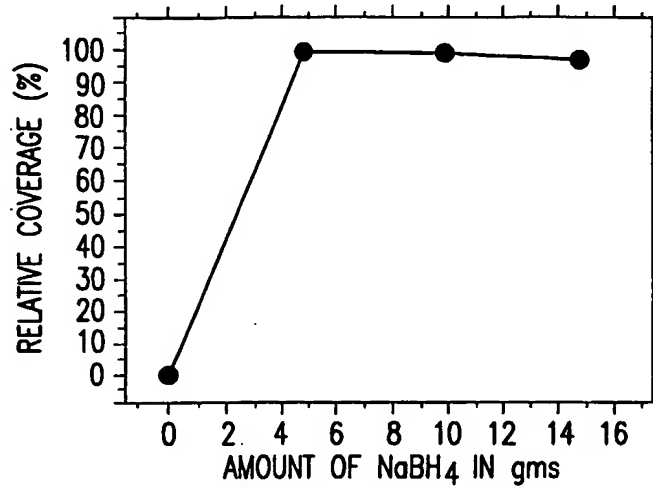


FIG.15

CVs FOR SAMPLES MINERALIZED IN 1:3 PQ SOLUTION WITH NO
CURRENT AND WITH DIFFERENT AMOUNTS OF SODIUM BOROHYDRIDE
SAMPLES WERE DRIED IN AIR FOR 24 HOURS AND LEFT IN WATER
FOR 1 WEEK

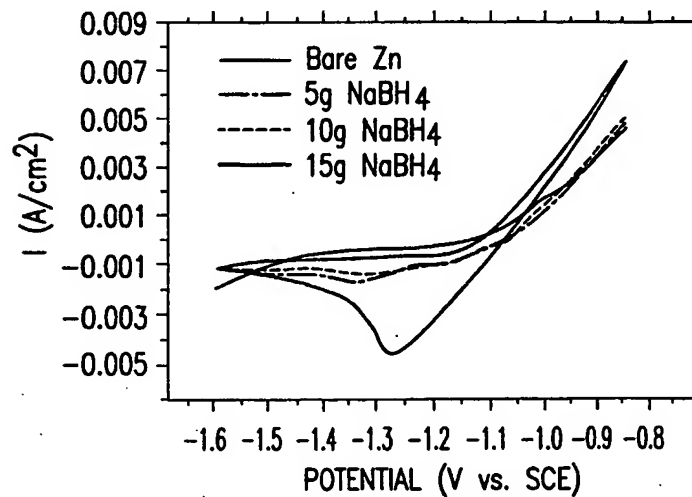


FIG.16

SUBSTITUTE SHEET (RULE 26)

CHANGE IN THE INHIBITING EFFICIENCY FOR SAMPLES MINERALIZED IN 1:3 PQ SOLUTION WITH NO CURRENT AND WITH DIFFERENT AMOUNTS OF SODIUM BOROHYDRIDE
SAMPLES WERE DRIED IN AIR FOR 24 HOURS AND LEFT
IN WATER FOR 1 WEEK

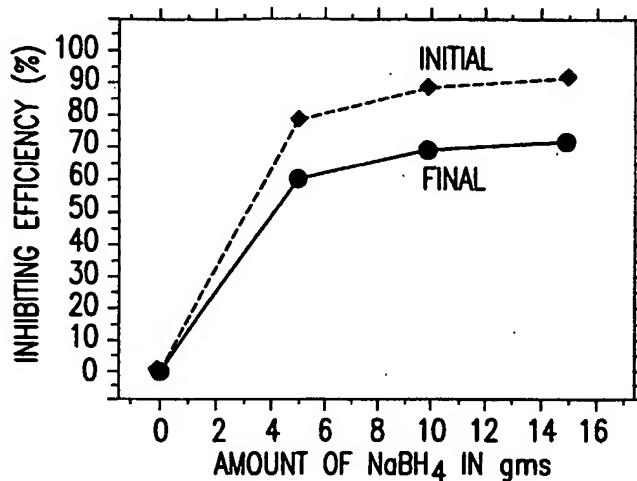


FIG.17

CVs FOR SAMPLES MINERALIZED IN 1:3 PQ SOLUTION WITH NO CURRENT AND WITH DIFFERENT AMOUNTS OF SODIUM BOROHYDRIDE
SAMPLES WERE DRIED AT 175°C FOR 1 HOUR AND LEFT IN WATER
FOR 1 WEEK

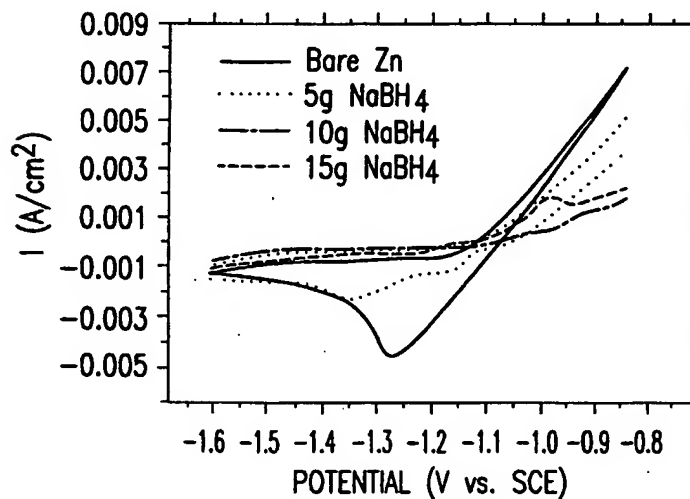


FIG.18

SUBSTITUTE SHEET (RULE 26)

CHANGE IN THE INHIBITING EFFICIENCY FOR SAMPLES
MINERALIZED IN 1:3 PQ SOLUTION WITH NO CURRENT AND WITH
DIFFERENT AMOUNTS OF SODIUM BOROHYDRIDE
SAMPLES WERE DRIED AT 175°C FOR 1 HOUR AND LEFT IN WATER FOR 1 WEEK

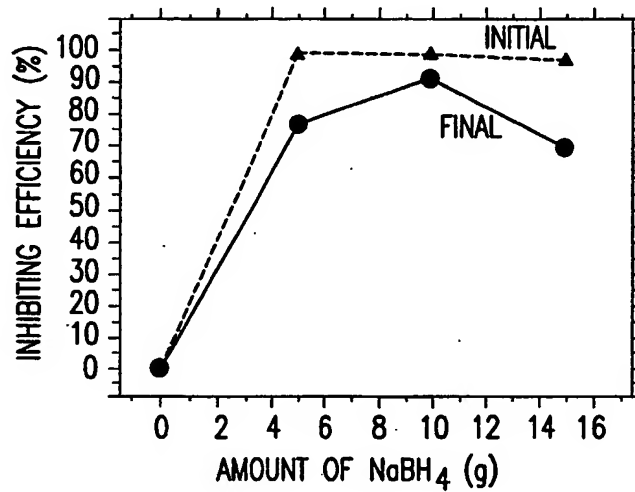
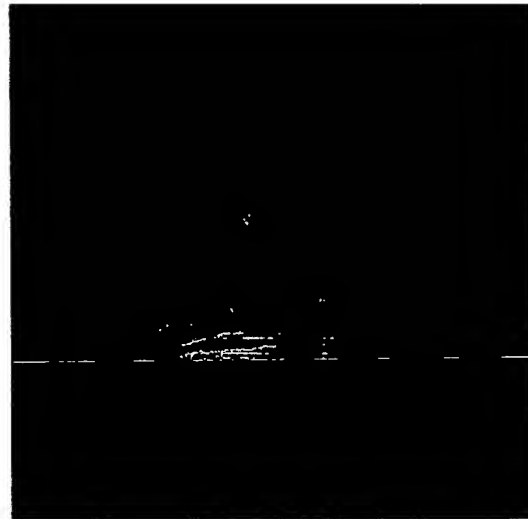


FIG.19

Change in Morphology for sample mineralized in 1:3 PQ solution with no current and with 10g/L of sodium Borohydride
Samples were heated at 175° C for 1 hour.

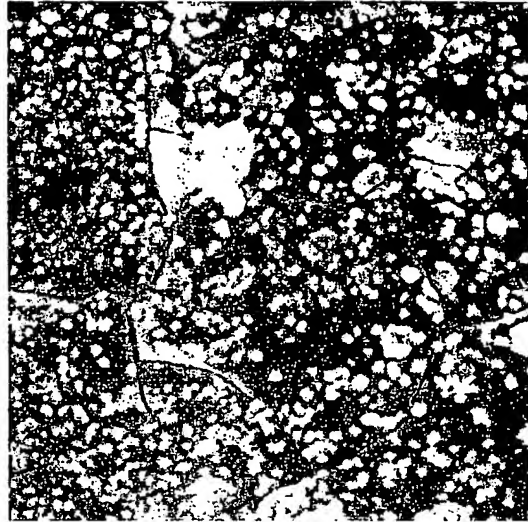
Before Corrosion



2 μm

Magnification: 2000X

After Corrosion



Magnification: 500X

FIG. 20

CHANGE IN Si CONCENTRATION FOR SAMPLES MINERALIZED IN
1:3 PQ SOLUTION WITH NO CURRENT AND WITH DIFFERENT AMOUNTS OF SODIUM BOROHYDRIDE
SAMPLES WERE DRIED IN AIR FOR 24 HOURS
AND LEFT IN WATER FOR 1 WEEK

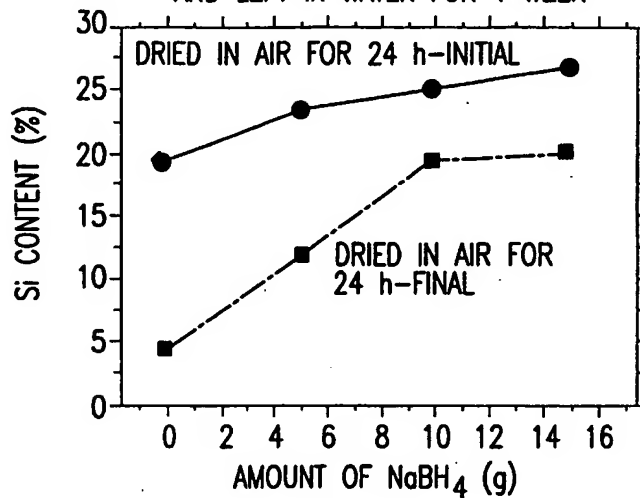


FIG.21

CHANGE IN Si CONCENTRATION FOR SAMPLES MINERALIZED IN
1:3 PQ SOLUTION WITH NO CURRENT AND WITH DIFFERENT AMOUNTS OF SODIUM BOROHYDRIDE
SAMPLES WERE DRIED IN AIR FOR 24 HOURS
AND LEFT IN WATER FOR 1 WEEK

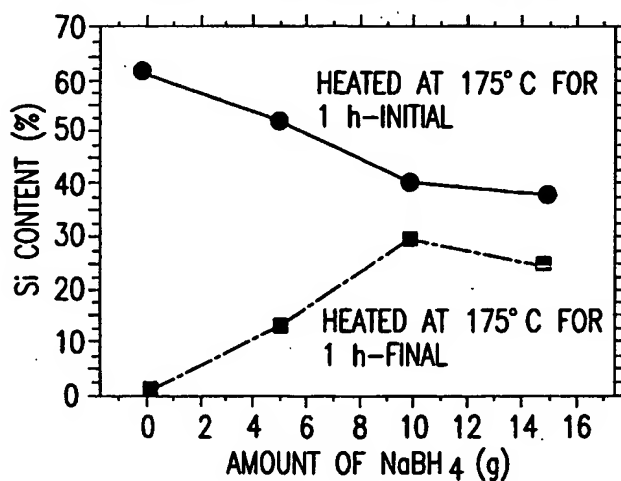


FIG.22

SUBSTITUTE SHEET (RULE 26)

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Organization
International Bureau



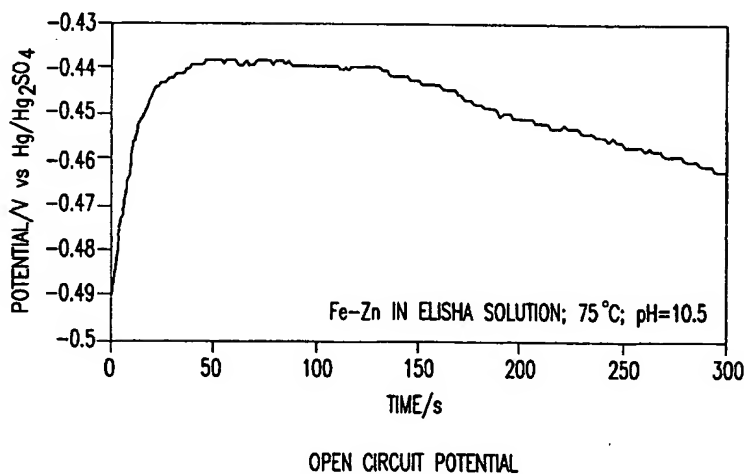
(43) International Publication Date
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- (71) Applicant: ELISHA HOLDING LLC [US/US]; 2000 US HWY 63 South, Moberly, MO 65270 (US).
- (72) Inventors: HEIMANN, Robert, L.; #2 Sunrise Circle, Centralia, MO 65240 (US). POPOV, Branko; 348 Conrad Circle, Columbia, SC 29212 (US). FLINT, Bruce; 1500 Affirmed, Columbia, MO 65202 (US). SLAVKOV, Dragan; 1600 Park Circle, Apartment #15, Columbia, SC 29212 (US). BISHOP, Craig, V.; 1750 Overview Drive, Rock Hill, SC 29730 (US).
- (74) Agent: BOYER, Michael, K.; Chief Patent Counsel, Orscheln Management Co, 2000 US HWY 63 South, Moberly, MO 65270 (US).
- (81) Designated States (*national*): AE, AG, AL, AM, AT, AU, AZ, BA, BB, BG, BR, BY, BZ, CA, CH, CN, CO, CR, CU, CZ, DE, DK, DM, DZ, EC, EE, ES, FI, GB, GD, GE, GH, GM, HR, HU, ID, IL, IN, IS, JP, KE, KG, KP, KR, KZ, LC, LK, LR, LS, LT, LU, LV, MA, MD, MG, MK, MN, MW, MX, MZ, NO, NZ, OM, PH, PL, PT, RO, RU, SD, SE, SG, SI, SK, SL, TJ, TM, TN, TR, TT, TZ, UA, UG, UZ, VN, YU, ZA, ZM, ZW.
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- Published:
— with international search report
— before the expiration of the time limit for amending the claims and to be republished in the event of receipt of amendments
- (88) Date of publication of the international search report: 14 October 2004
- For two-letter codes and other abbreviations, refer to the "Guidance Notes on Codes and Abbreviations" appearing at the beginning of each regular issue of the PCT Gazette.

(54) Title: AN ELECTROLESS PROCESS FOR TREATING METALLIC SURFACES AND PRODUCTS FORMED THEREBY



(57) Abstract: The disclosure relates to process for forming a deposit on the surface of a metallic or conductive surface. The process employs an electroless process to deposit a silicate containing coating or film upon a metallic or conductive surface.

WO 2003/012167 A3

INTERNATIONAL SEARCH REPORT

International Application No.

PCT/US 02/24716

A. CLASSIFICATION OF SUBJECT MATTER

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According to International Patent Classification (IPC) or to both national classification and IPC

B. FIELDS SEARCHED

Minimum documentation searched (classification system followed by classification symbols)

IPC 7 C23C C04B C09D

Documentation searched other than minimum documentation to the extent that such documents are included in the fields searched

Electronic data base consulted during the International search (name of data base and, where practical, search terms used)

EPO-Internal, WPI Data, PAJ

C. DOCUMENTS CONSIDERED TO BE RELEVANT

Category *	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
X	US 5 326 594 A (SABATA ASHOK ET AL) 5 July 1994 (1994-07-05)	1,3,5,6, 9,11,14, 16,18 7
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X	US 5 478 655 A (SABATA ASHOK ET AL) 26 December 1995 (1995-12-26) column 4, line 47 - column 5, line 58; claims 1,2,4,5 ----- -/--	1,3,5,6, 9,11,13, 16,18

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13 August 2004

Date of mailing of the international search report

20/08/2004

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NL - 2280 HV Rijswijk
Tel. (+31-70) 340-2040, Tx. 31 651 epo nl,
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INTERNATIONAL SEARCH REPORT

International Application No

PCT/US 02/24716

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X	US 5 108 793 A (VAN OOIJ WIM J ET AL) 28 April 1992 (1992-04-28) column 3, lines 50-68 column 4, lines 32-65 column 5, lines 1-5; claims 1,3-13,15-17	1,5,6,9, 11
X	US 4 466 832 A (YOKOI HIROMASA ET AL) 21 August 1984 (1984-08-21) column 2, lines 41-49 column 3, lines 5-65 column 4, lines 36-38,43-48; claims 1-12	2,12
X	US 3 977 888 A (SANO RYUICHI ET AL) 31 August 1976 (1976-08-31) column 1, lines 8-32,52-62 column 4, lines 32-65 column 5, lines 1-17,21-26; claims 1-3,5-7; example 1	2,12
X	US 5 068 134 A (COLE JAMES A ET AL) 26 November 1991 (1991-11-26) column 3, line 40 - column 4, line 6 column 4, lines 25-28 column 5, lines 7-9; claims 1-3,7,8,10-16	19
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A	US 5 433 976 A (OOIJ WIM J VAN ET AL) 18 July 1995 (1995-07-18) column 1, line 64 - column 2, line 60 column 3, lines 9-15 column 4, lines 19-58; claims 1-13	1-19
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